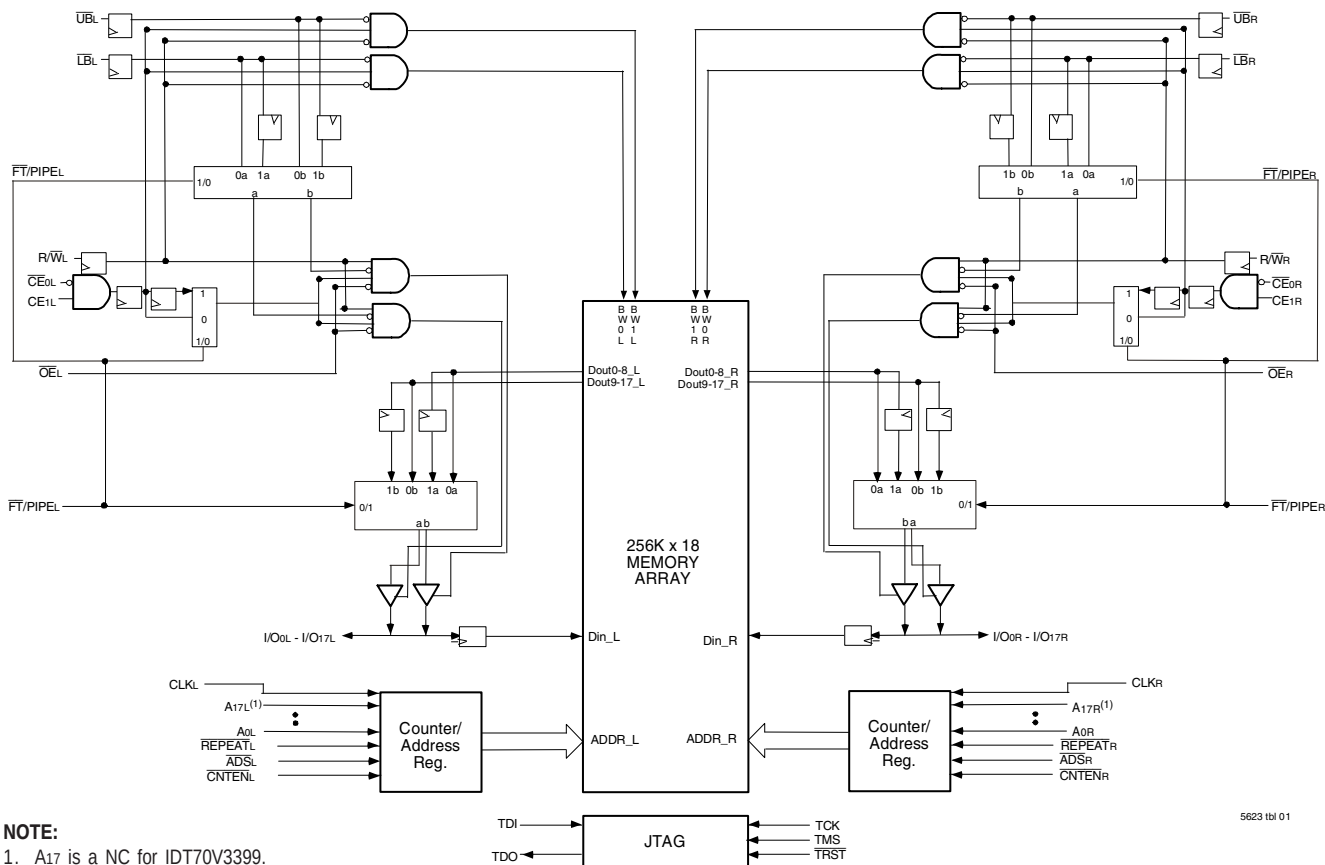


#### Features:

- ♦ **True Dual-Port memory cells** which allow **simultaneous access of the same memory location**
- ♦ **High-speed data access**
  - Commercial: 3.6ns (166MHz)/4.2ns (133MHz) (max.)
  - Industrial: 4.2ns (133MHz) (max.)
- ♦ **Selectable Pipelined or Flow-Through output mode**
  - Due to limited pin count PL/FT option is not supported on the 128-pin TQFP package. Device is pipelined outputs only on each port.
- ♦ **Counter enable and repeat features**
- ♦ **Dual chip enables allow for depth expansion without additional logic**
- ♦ **Full synchronous operation on both ports**
  - 6ns cycle time, 166MHz operation (6Gbps bandwidth)
  - Fast 3.6ns clock to data out
  - 1.7ns setup to clock and 0.5ns hold on all control, data, and address inputs @ 166MHz
  - Data input, address, byte enable and control registers
- Self-timed write allows fast cycle time
- ♦ **Separate byte controls for multiplexed bus and bus matching compatibility**
- ♦ **Dual Cycle Deselect (DCD) for Pipelined Output mode**
- ♦ **LVTTTL-compatible, single 3.3V (±150mV) power supply for core**
- ♦ **LVTTTL compatible, selectable 3.3V (±150mV) or 2.5V (±100mV) power supply for I/Os and control signals on each port**
- ♦ **Industrial temperature range (-40°C to +85°C) is available at 133MHz.**
- ♦ **Available in a 128-pin Thin Quad Flatpack, 208-pin fine pitch Ball Grid Array, and 256-pin Ball Grid Array**
- ♦ **Supports JTAG features compliant to IEEE 1149.1**
  - Due to limited pin count, JTAG is not supported on the 128-pin TQFP package
- ♦ **Green parts available, see ordering information**

#### Functional Block Diagram



5623 1bl 01

NOVEMBER 2019

## Description:

The IDT70V3319/99 is a high-speed 256/128K x 18 bit synchronous Dual-Port RAM. The memory array utilizes Dual-Port memory cells to allow simultaneous access of any address from both ports. Registers on control, data, and address inputs provide minimal setup and hold times. The timing latitude provided by this approach allows systems to be designed with very short cycle times. With an input data register, the IDT70V3319/99 has been optimized for applications having unidirectional

or bidirectional data flow in bursts. An automatic power down feature, controlled by  $\overline{CE}_0$  and  $\overline{CE}_1$ , permits the on-chip circuitry of each port to enter a very low standby power mode.

The 70V3319/99 can support an operating voltage of either 3.3V or 2.5V on one or both ports, controllable by the OPT pins. The power supply for the core of the device ( $V_{DD}$ ) remains at 3.3V.

## Pin Configuration<sup>(1,2,3,4,5)</sup>

| 1                  | 2                  | 3                    | 4                    | 5                                                                                                                            | 6                 | 7                | 8                        | 9                           | 10                       | 11                         | 12                          | 13              | 14              | 15                | 16                | 17                |                   |   |
|--------------------|--------------------|----------------------|----------------------|------------------------------------------------------------------------------------------------------------------------------|-------------------|------------------|--------------------------|-----------------------------|--------------------------|----------------------------|-----------------------------|-----------------|-----------------|-------------------|-------------------|-------------------|-------------------|---|
| I/O <sub>9L</sub>  | NC                 | V <sub>SS</sub>      | TDO                  | NC                                                                                                                           | A <sub>16L</sub>  | A <sub>12L</sub> | A <sub>8L</sub>          | NC                          | V <sub>DD</sub>          | CLK <sub>L</sub>           | $\overline{\text{CNTEN}}_L$ | A <sub>4L</sub> | A <sub>0L</sub> | OPT <sub>L</sub>  | NC                | V <sub>SS</sub>   | A                 |   |
| NC                 | V <sub>SS</sub>    | NC                   | TDI                  | A <sub>17L</sub> <sup>(1)</sup>                                                                                              | A <sub>13L</sub>  | A <sub>9L</sub>  | NC                       | $\overline{\text{CE}}_{0L}$ | V <sub>SS</sub>          | $\overline{\text{ADS}}_L$  | A <sub>5L</sub>             | A <sub>1L</sub> | V <sub>SS</sub> | V <sub>DDQR</sub> | I/O <sub>8L</sub> | NC                | B                 |   |
| V <sub>DDQL</sub>  | I/O <sub>9R</sub>  | V <sub>DDQR</sub>    | PIPE/FT <sub>L</sub> | NC                                                                                                                           | A <sub>14L</sub>  | A <sub>10L</sub> | $\overline{\text{UB}}_L$ | CE <sub>1L</sub>            | V <sub>SS</sub>          | R/ $\overline{\text{W}}_L$ | A <sub>6L</sub>             | A <sub>2L</sub> | V <sub>DD</sub> | I/O <sub>8R</sub> | NC                | V <sub>SS</sub>   | C                 |   |
| NC                 | V <sub>SS</sub>    | I/O <sub>10L</sub>   | NC                   | A <sub>15L</sub>                                                                                                             | A <sub>11L</sub>  | A <sub>7L</sub>  | $\overline{\text{LB}}_L$ | V <sub>DD</sub>             | $\overline{\text{OE}}_L$ | REPEAT <sub>L</sub>        | A <sub>3L</sub>             | V <sub>DD</sub> | NC              | V <sub>DDQL</sub> | I/O <sub>7L</sub> | I/O <sub>7R</sub> | D                 |   |
| I/O <sub>11L</sub> | NC                 | V <sub>DDQR</sub>    | I/O <sub>10R</sub>   | <div>70V3319/99<br/>BF208<sup>(6)</sup><br/>BFG208<sup>(6)</sup><br/><br/>208-Pin<br/>fpBGA<br/>Top View<sup>(7)</sup></div> |                   |                  |                          |                             |                          |                            |                             |                 |                 | I/O <sub>6L</sub> | NC                | V <sub>SS</sub>   | NC                | E |
| V <sub>DDQL</sub>  | I/O <sub>11R</sub> | NC                   | V <sub>SS</sub>      |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | V <sub>SS</sub>   | I/O <sub>6R</sub> | NC                | V <sub>DDQR</sub> | F |
| NC                 | V <sub>SS</sub>    | I/O <sub>12L</sub>   | NC                   |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | NC                | V <sub>DDQL</sub> | I/O <sub>5L</sub> | NC                | G |
| V <sub>DD</sub>    | NC                 | V <sub>DDQR</sub>    | I/O <sub>12R</sub>   |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | V <sub>DD</sub>   | NC                | V <sub>SS</sub>   | I/O <sub>5R</sub> | H |
| V <sub>DDQL</sub>  | V <sub>DD</sub>    | V <sub>SS</sub>      | V <sub>SS</sub>      |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | V <sub>SS</sub>   | V <sub>DD</sub>   | V <sub>SS</sub>   | V <sub>DDQR</sub> | J |
| I/O <sub>14R</sub> | V <sub>SS</sub>    | I/O <sub>13R</sub>   | V <sub>SS</sub>      |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | I/O <sub>3R</sub> | V <sub>DDQL</sub> | I/O <sub>4R</sub> | V <sub>SS</sub>   | K |
| NC                 | I/O <sub>14L</sub> | V <sub>DDQR</sub>    | I/O <sub>13L</sub>   |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | NC                | I/O <sub>3L</sub> | V <sub>SS</sub>   | I/O <sub>4L</sub> | L |
| V <sub>DDQL</sub>  | NC                 | I/O <sub>15R</sub>   | V <sub>SS</sub>      |                                                                                                                              |                   |                  |                          |                             |                          |                            |                             |                 |                 | V <sub>SS</sub>   | NC                | I/O <sub>2R</sub> | V <sub>DDQR</sub> | M |
| NC                 | V <sub>SS</sub>    | NC                   | I/O <sub>15L</sub>   | I/O <sub>1R</sub>                                                                                                            | V <sub>DDQL</sub> | NC               | I/O <sub>2L</sub>        | N                           |                          |                            |                             |                 |                 |                   |                   |                   |                   |   |
| I/O <sub>16R</sub> | I/O <sub>16L</sub> | V <sub>DDQR</sub>    | NC                   | $\overline{\text{TRST}}$                                                                                                     | A <sub>16R</sub>  | A <sub>12R</sub> | A <sub>8R</sub>          | NC                          | V <sub>DD</sub>          | CLK <sub>R</sub>           | $\overline{\text{CNTEN}}_R$ | A <sub>4R</sub> | NC              | I/O <sub>1L</sub> | V <sub>SS</sub>   | NC                | P                 |   |
| V <sub>SS</sub>    | NC                 | I/O <sub>17R</sub>   | TCK                  | A <sub>17R</sub> <sup>(1)</sup>                                                                                              | A <sub>13R</sub>  | A <sub>9R</sub>  | NC                       | $\overline{\text{CE}}_{0R}$ | V <sub>SS</sub>          | $\overline{\text{ADS}}_R$  | A <sub>5R</sub>             | A <sub>1R</sub> | V <sub>SS</sub> | V <sub>DDQL</sub> | I/O <sub>0R</sub> | V <sub>DDQR</sub> | R                 |   |
| NC                 | I/O <sub>17L</sub> | V <sub>DDQL</sub>    | TMS                  | NC                                                                                                                           | A <sub>14R</sub>  | A <sub>10R</sub> | $\overline{\text{UB}}_R$ | CE <sub>1R</sub>            | V <sub>SS</sub>          | R/ $\overline{\text{W}}_R$ | A <sub>6R</sub>             | A <sub>2R</sub> | V <sub>SS</sub> | NC                | V <sub>SS</sub>   | NC                | T                 |   |
| V <sub>SS</sub>    | NC                 | PIPE/FT <sub>R</sub> | NC                   | A <sub>15R</sub>                                                                                                             | A <sub>11R</sub>  | A <sub>7R</sub>  | $\overline{\text{LB}}_R$ | V <sub>DD</sub>             | $\overline{\text{OE}}_R$ | REPEAT <sub>R</sub>        | A <sub>3R</sub>             | A <sub>0R</sub> | V <sub>DD</sub> | OPT <sub>R</sub>  | NC                | I/O <sub>0L</sub> | U                 |   |

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### NOTES:

1. A<sub>17</sub> is a NC for IDT70V3399.
2. All V<sub>DD</sub> pins must be connected to 3.3V power supply.
3. All V<sub>DDQ</sub> pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to V<sub>IH</sub> (3.3V), and 2.5V if OPT pin for that port is set to V<sub>IL</sub> (0V).
4. All V<sub>SS</sub> pins must be connected to ground supply.
5. Package body is approximately 15mm x 15mm x 1.4mm with 0.8mm ball pitch.
6. This package code is used to reference the package diagram.
7. This text does not indicate orientation of the actual part-marking.

# Pin Configuration<sup>(1,2,3,4,5)</sup> (con't.)

70V3319/99

BC256<sup>(6)</sup>

BCG256<sup>(6)</sup>

256-Pin BGA

Top View<sup>(7)</sup>

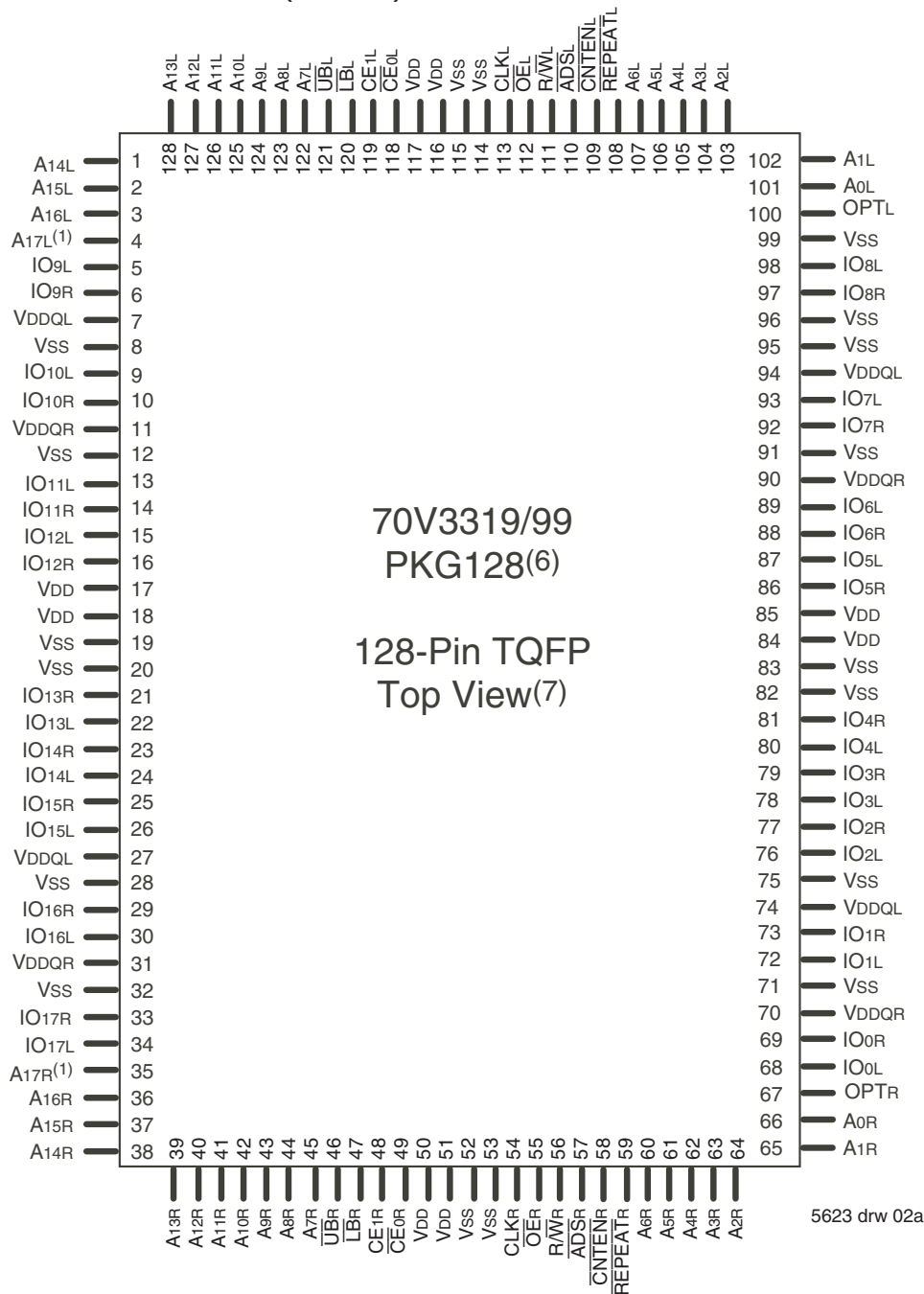
|              |              |              |                           |             |             |             |             |             |              |                |              |              |              |              |              |
|--------------|--------------|--------------|---------------------------|-------------|-------------|-------------|-------------|-------------|--------------|----------------|--------------|--------------|--------------|--------------|--------------|
| A1<br>NC     | A2<br>TDI    | A3<br>NC     | A4<br>A17L <sup>(1)</sup> | A5<br>A14L  | A6<br>A11L  | A7<br>A8L   | A8<br>NC    | A9<br>CE1L  | A10<br>OEL   | A11<br>CNTENL  | A12<br>A5L   | A13<br>A2L   | A14<br>A0L   | A15<br>NC    | A16<br>NC    |
| B1<br>NC     | B2<br>NC     | B3<br>TDO    | B4<br>NC                  | B5<br>A15L  | B6<br>A12L  | B7<br>A9L   | B8<br>UBL   | B9<br>CE0L  | B10<br>R/WL  | B11<br>REPEATL | B12<br>A4L   | B13<br>A1L   | B14<br>VDD   | B15<br>NC    | B16<br>NC    |
| C1<br>NC     | C2<br>I/O9L  | C3<br>VSS    | C4<br>A16L                | C5<br>A13L  | C6<br>A10L  | C7<br>A7L   | C8<br>NC    | C9<br>LBL   | C10<br>CLKL  | C11<br>ADSL    | C12<br>A6L   | C13<br>A3L   | C14<br>OPTL  | C15<br>NC    | C16<br>I/O8L |
| D1<br>NC     | D2<br>I/O9R  | D3<br>NC     | D4<br>PIPE/FTL            | D5<br>VDDQL | D6<br>VDDQL | D7<br>VDDQR | D8<br>VDDQR | D9<br>VDDQL | D10<br>VDDQL | D11<br>VDDQR   | D12<br>VDDQR | D13<br>VDD   | D14<br>NC    | D15<br>NC    | D16<br>I/O8R |
| E1<br>I/O10R | E2<br>I/O10L | E3<br>NC     | E4<br>VDDQL               | E5<br>VDD   | E6<br>VDD   | E7<br>VSS   | E8<br>VSS   | E9<br>VSS   | E10<br>VSS   | E11<br>VDD     | E12<br>VDD   | E13<br>VDDQR | E14<br>NC    | E15<br>I/O7L | E16<br>I/O7R |
| F1<br>I/O11L | F2<br>NC     | F3<br>I/O11R | F4<br>VDDQL               | F5<br>VDD   | F6<br>VSS   | F7<br>VSS   | F8<br>VSS   | F9<br>VSS   | F10<br>VSS   | F11<br>VSS     | F12<br>VDD   | F13<br>VDDQR | F14<br>I/O6R | F15<br>NC    | F16<br>I/O6L |
| G1<br>NC     | G2<br>NC     | G3<br>I/O12L | G4<br>VDDQR               | G5<br>VSS   | G6<br>VSS   | G7<br>VSS   | G8<br>VSS   | G9<br>VSS   | G10<br>VSS   | G11<br>VSS     | G12<br>VSS   | G13<br>VDDQL | G14<br>I/O5L | G15<br>NC    | G16<br>NC    |
| H1<br>NC     | H2<br>I/O12R | H3<br>NC     | H4<br>VDDQR               | H5<br>VSS   | H6<br>VSS   | H7<br>VSS   | H8<br>VSS   | H9<br>VSS   | H10<br>VSS   | H11<br>VSS     | H12<br>VSS   | H13<br>VDDQL | H14<br>NC    | H15<br>NC    | H16<br>I/O5R |
| J1<br>I/O13L | J2<br>I/O14R | J3<br>I/O13R | J4<br>VDDQL               | J5<br>VSS   | J6<br>VSS   | J7<br>VSS   | J8<br>VSS   | J9<br>VSS   | J10<br>VSS   | J11<br>VSS     | J12<br>VSS   | J13<br>VDDQR | J14<br>I/O4R | J15<br>I/O3R | J16<br>I/O4L |
| K1<br>NC     | K2<br>NC     | K3<br>I/O14L | K4<br>VDDQL               | K5<br>VSS   | K6<br>VSS   | K7<br>VSS   | K8<br>VSS   | K9<br>VSS   | K10<br>VSS   | K11<br>VSS     | K12<br>VSS   | K13<br>VDDQR | K14<br>NC    | K15<br>NC    | K16<br>I/O3L |
| L1<br>I/O15L | L2<br>NC     | L3<br>I/O15R | L4<br>VDDQR               | L5<br>VDD   | L6<br>VSS   | L7<br>VSS   | L8<br>VSS   | L9<br>VSS   | L10<br>VSS   | L11<br>VSS     | L12<br>VDD   | L13<br>VDDQL | L14<br>I/O2L | L15<br>NC    | L16<br>I/O2R |
| M1<br>I/O16R | M2<br>I/O16L | M3<br>NC     | M4<br>VDDQR               | M5<br>VDD   | M6<br>VDD   | M7<br>VSS   | M8<br>VSS   | M9<br>VSS   | M10<br>VSS   | M11<br>VDD     | M12<br>VDD   | M13<br>VDDQL | M14<br>I/O1R | M15<br>I/O1L | M16<br>NC    |
| N1<br>NC     | N2<br>I/O17R | N3<br>NC     | N4<br>PIPE/FTL            | N5<br>VDDQR | N6<br>VDDQR | N7<br>VDDQL | N8<br>VDDQL | N9<br>VDDQR | N10<br>VDDQR | N11<br>VDDQL   | N12<br>VDDQL | N13<br>VDD   | N14<br>NC    | N15<br>I/O0R | N16<br>NC    |
| P1<br>NC     | P2<br>I/O17L | P3<br>TMS    | P4<br>A16R                | P5<br>A13R  | P6<br>A10R  | P7<br>A7R   | P8<br>NC    | P9<br>LBR   | P10<br>CLKR  | P11<br>ADSR    | P12<br>A6R   | P13<br>A3R   | P14<br>NC    | P15<br>NC    | P16<br>I/O0L |
| R1<br>NC     | R2<br>NC     | R3<br>TRST   | R4<br>NC                  | R5<br>A15R  | R6<br>A12R  | R7<br>A9R   | R8<br>UBR   | R9<br>CE0R  | R10<br>R/WR  | R11<br>REPEATR | R12<br>A4R   | R13<br>A1R   | R14<br>OPTR  | R15<br>NC    | R16<br>NC    |
| T1<br>NC     | T2<br>TCK    | T3<br>NC     | T4<br>A17R <sup>(1)</sup> | T5<br>A14R  | T6<br>A11R  | T7<br>A8R   | T8<br>NC    | T9<br>CE1R  | T10<br>OER   | T11<br>CNTENR  | T12<br>A5R   | T13<br>A2R   | T14<br>A0R   | T15<br>NC    | T16<br>NC    |

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## NOTES:

1. A17 is a NC for IDT70V3399.
2. All VDD pins must be connected to 3.3V power supply.
3. All VDDQ pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to VIH (3.3V), and 2.5V if OPT pin for that port is set to VIL (0V).
4. All VSS pins must be connected to ground supply.
5. Package body is approximately 17mm x 17mm x 1.4mm, with 1.0mm ball-pitch.
6. This package code is used to reference the package diagram.
7. This text does not indicate orientation of the actual part-marking.

# Pin Configuration<sup>(1,2,3,4,5,8,9)</sup> (con't.)



## NOTES:

- A17 is a NC for IDT70V3399.
- All VDD pins must be connected to 3.3V power supply.
- All VDDQ pins must be connected to appropriate power supply: 3.3V if OPT pin for that port is set to V<sub>IH</sub> (3.3V), and 2.5V if OPT pin for that port is set to V<sub>IL</sub> (0V).
- All VSS pins must be connected to ground supply.
- Package body is approximately 14mm x 20mm x 1.4mm.
- This package code is used to reference the package diagram.
- This text does not indicate orientation of the actual part-marking.
- PIPE/FT option in PKG128 is not supported due to limitation in pin count. Device is pipelined outputs only on each port.
- Due to the limited pin count, JTAG is not supported in the PKG128 package.

## Pin Names

| Left Port                             | Right Port                            | Names                                                     |
|---------------------------------------|---------------------------------------|-----------------------------------------------------------|
| $\overline{CE}_{0L}$ , $CE_{1L}$      | $\overline{CE}_{0R}$ , $CE_{1R}$      | Chip Enables <sup>(6)</sup>                               |
| $R/\overline{W}_L$                    | $R/\overline{W}_R$                    | Read/Write Enable                                         |
| $\overline{OE}_L$                     | $\overline{OE}_R$                     | Output Enable                                             |
| $A_{0L}$ - $A_{17L}$ <sup>(1)</sup>   | $A_{0R}$ - $A_{17R}$ <sup>(1)</sup>   | Address                                                   |
| $I/O_{0L}$ - $I/O_{17L}$              | $I/O_{0R}$ - $I/O_{17R}$              | Data Input/Output                                         |
| $CLK_L$                               | $CLK_R$                               | Clock                                                     |
| $PIPE/\overline{FT}_L$ <sup>(5)</sup> | $PIPE/\overline{FT}_R$ <sup>(5)</sup> | Pipeline/Flow-Through                                     |
| $\overline{ADS}_L$                    | $\overline{ADS}_R$                    | Address Strobe Enable                                     |
| $\overline{CNTEN}_L$                  | $\overline{CNTEN}_R$                  | Counter Enable                                            |
| $\overline{REPEAT}_L$                 | $\overline{REPEAT}_R$                 | Counter Repeat <sup>(4)</sup>                             |
| $\overline{UB}_L$                     | $\overline{UB}_R$                     | Upper Byte Enable ( $I/O_9$ - $I/O_{17}$ ) <sup>(6)</sup> |
| $\overline{LB}_L$                     | $\overline{LB}_R$                     | Lower Byte Enable ( $I/O_0$ - $I/O_8$ ) <sup>(6)</sup>    |
| $V_{DDQL}$                            | $V_{DDQR}$                            | Power (I/O Bus) (3.3V or 2.5V) <sup>(2)</sup>             |
| $OPT_L$                               | $OPT_R$                               | Option for selecting $V_{DDQX}$ <sup>(2,3)</sup>          |
| $V_{DD}$                              |                                       | Power (3.3V) <sup>(2)</sup>                               |
| $V_{SS}$                              |                                       | Ground (0V)                                               |
| $TDI$                                 |                                       | Test Data Input                                           |
| $TDO$                                 |                                       | Test Data Output                                          |
| $TCK$                                 |                                       | Test Logic Clock (10MHz)                                  |
| $TMS$                                 |                                       | Test Mode Select                                          |
| $\overline{TRST}$                     |                                       | Reset (Initialize TAP Controller)                         |

5623 tbl 01

### NOTES:

1.  $A_{17}$  is a NC for IDT70V3399.
2.  $V_{DD}$ ,  $OPT_x$ , and  $V_{DDQX}$  must be set to appropriate operating levels prior to applying inputs on the I/Os and controls for that port.
3.  $OPT_x$  selects the operating voltage levels for the I/Os and controls on that port. If  $OPT_x$  is set to  $V_{IH}$  (3.3V), then that port's I/Os and controls will operate at 3.3V levels and  $V_{DDQX}$  must be supplied at 3.3V. If  $OPT_x$  is set to  $V_{IL}$  (0V), then that port's I/Os and address controls will operate at 2.5V levels and  $V_{DDQX}$  must be supplied at 2.5V. The  $OPT$  pins are independent of one another—both ports can operate at 3.3V levels, both can operate at 2.5V levels, or either can operate at 3.3V with the other at 2.5V.
4. When  $\overline{REPEAT}_x$  is asserted, the counter will reset to the last valid address loaded via  $\overline{ADS}_x$ .
5.  $PIPE/\overline{FT}$  option in PK-128 package is not supported due to limitation in pin count. Device is pipelined output mode only on each port.
6. Chip Enables and Byte Enables are double buffered when  $PL/\overline{FT} = V_{IH}$ , i.e., the signals take two cycles to deselect.

Truth Table I—Read/Write and Enable Control<sup>(1,2,3)</sup>

| $\overline{OE}$ | CLK | $\overline{CE_0}$ | $CE_1$ | $\overline{UB}$ | $\overline{LB}$ | R/ $\overline{W}$ | Upper Byte<br>I/O <sub>9-17</sub> | Lower Byte<br>I/O <sub>0-8</sub> | MODE                     |
|-----------------|-----|-------------------|--------|-----------------|-----------------|-------------------|-----------------------------------|----------------------------------|--------------------------|
| X               | ↑   | H                 | X      | X               | X               | X                 | High-Z                            | High-Z                           | Deselected—Power Down    |
| X               | ↑   | X                 | L      | X               | X               | X                 | High-Z                            | High-Z                           | Deselected—Power Down    |
| X               | ↑   | L                 | H      | H               | H               | X                 | High-Z                            | High-Z                           | Both Bytes Deselected    |
| X               | ↑   | L                 | H      | H               | L               | L                 | High-Z                            | D <sub>IN</sub>                  | Write to Lower Byte Only |
| X               | ↑   | L                 | H      | L               | H               | L                 | D <sub>IN</sub>                   | High-Z                           | Write to Upper Byte Only |
| X               | ↑   | L                 | H      | L               | L               | L                 | D <sub>IN</sub>                   | D <sub>IN</sub>                  | Write to Both Bytes      |
| L               | ↑   | L                 | H      | H               | L               | H                 | High-Z                            | D <sub>OUT</sub>                 | Read Lower Byte Only     |
| L               | ↑   | L                 | H      | L               | H               | H                 | D <sub>OUT</sub>                  | High-Z                           | Read Upper Byte Only     |
| L               | ↑   | L                 | H      | L               | L               | H                 | D <sub>OUT</sub>                  | D <sub>OUT</sub>                 | Read Both Bytes          |
| H               | ↑   | L                 | H      | L               | L               | X                 | High-Z                            | High-Z                           | Outputs Disabled         |

5623 tbl 02

NOTES:

1. "H" = V<sub>IH</sub>, "L" = V<sub>IL</sub>, "X" = Don't Care.
2.  $\overline{ADS}$ ,  $\overline{CNTEN}$ ,  $\overline{REPEAT}$  = X.
3.  $\overline{OE}$  is an asynchronous input signal.

Truth Table II—Address Counter Control<sup>(1,2)</sup>

| External<br>Address | Previous<br>Internal<br>Address | Internal<br>Address<br>Used | CLK | $\overline{ADS}$ | $\overline{CNTEN}$ | $\overline{REPEAT}^{(6)}$ | I/O <sup>(8)</sup>    | MODE                                                              |
|---------------------|---------------------------------|-----------------------------|-----|------------------|--------------------|---------------------------|-----------------------|-------------------------------------------------------------------|
| X                   | X                               | A <sub>n</sub>              | ↑   | X                | X                  | L <sup>(4)</sup>          | D <sub>IO</sub> (0)   | Counter Reset to last valid $\overline{ADS}$ load                 |
| A <sub>n</sub>      | X                               | A <sub>n</sub>              | ↑   | L <sup>(4)</sup> | X                  | H                         | D <sub>IO</sub> (n)   | External Address Used                                             |
| A <sub>n</sub>      | A <sub>p</sub>                  | A <sub>p</sub>              | ↑   | H                | H                  | H                         | D <sub>IO</sub> (p)   | External Address Blocked—Counter disabled (A <sub>p</sub> reused) |
| X                   | A <sub>p</sub>                  | A <sub>p</sub> + 1          | ↑   | H                | L <sup>(5)</sup>   | H                         | D <sub>IO</sub> (p+1) | Counter Enabled—Internal Address generation                       |

5623 tbl 03

NOTES:

1. "H" = V<sub>IH</sub>, "L" = V<sub>IL</sub>, "X" = Don't Care.
2. Read and write operations are controlled by the appropriate setting of R/ $\overline{W}$ ,  $\overline{CE_0}$ ,  $CE_1$ ,  $\overline{UB}$ ,  $\overline{LB}$  and  $\overline{OE}$ .
3. Outputs configured in flow-through output mode: if outputs are in pipelined mode the data out will be delayed by one cycle.
4.  $\overline{ADS}$  and  $\overline{REPEAT}$  are independent of all other memory control signals including  $\overline{CE_0}$ ,  $CE_1$  and  $\overline{UB}$ ,  $\overline{LB}$ .
5. The address counter advances if  $\overline{CNTEN}$  = V<sub>IL</sub> on the rising edge of CLK, regardless of all other memory control signals including  $\overline{CE_0}$ ,  $CE_1$ ,  $\overline{UB}$ ,  $\overline{LB}$ .
6. When  $\overline{REPEAT}$  is asserted, the counter will reset to the last valid address loaded via  $\overline{ADS}$ . This value is not set at power-up: a known location should be loaded via  $\overline{ADS}$  during initialization if desired. Any subsequent  $\overline{ADS}$  access during operations will update the  $\overline{REPEAT}$  address location.

## Recommended Operating Temperature and Supply Voltage<sup>(1)</sup>

| Grade      | Ambient Temperature | GND | V <sub>DD</sub>  |
|------------|---------------------|-----|------------------|
| Commercial | 0°C to +70°C        | 0V  | 3.3V $\pm$ 150mV |
| Industrial | -40°C to +85°C      | 0V  | 3.3V $\pm$ 150mV |

5623 tbl 04

**NOTES:**

1. This is the parameter TA. This is the "instant on" case temperature.

## Recommended DC Operating Conditions with V<sub>DDQ</sub> at 2.5V

| Symbol           | Parameter                                     | Min.                | Typ. | Max.                                    | Unit |
|------------------|-----------------------------------------------|---------------------|------|-----------------------------------------|------|
| V <sub>DD</sub>  | Core Supply Voltage                           | 3.15                | 3.3  | 3.45                                    | V    |
| V <sub>DDQ</sub> | I/O Supply Voltage <sup>(2)</sup>             | 2.4                 | 2.5  | 2.6                                     | V    |
| V <sub>SS</sub>  | Ground                                        | 0                   | 0    | 0                                       | V    |
| V <sub>IH</sub>  | Input High Voltage (Address & Control Inputs) | 1.7                 | —    | V <sub>DDQ</sub> + 100mV <sup>(2)</sup> | V    |
| V <sub>IH</sub>  | Input High Voltage - I/O <sup>(3)</sup>       | 1.7                 | —    | V <sub>DDQ</sub> + 100mV <sup>(2)</sup> | V    |
| V <sub>IL</sub>  | Input Low Voltage                             | -0.3 <sup>(1)</sup> | —    | 0.7                                     | V    |

5623 tbl 05a

**NOTES:**

1. Undershoot of V<sub>IL</sub>  $\geq$  -1.5V for pulse width less than 10ns is allowed.
2. V<sub>TERM</sub> must not exceed V<sub>DDQ</sub> + 100mV.
3. To select operation at 2.5V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to V<sub>IL</sub> (0V), and V<sub>DDQX</sub> for that port must be supplied as indicated above.

## Absolute Maximum Ratings<sup>(1)</sup>

| Symbol                           | Rating                               | Commercial & Industrial | Unit |
|----------------------------------|--------------------------------------|-------------------------|------|
| V <sub>TERM</sub> <sup>(2)</sup> | Terminal Voltage with Respect to GND | -0.5 to +4.6            | V    |
| T <sub>BIAS</sub> <sup>(3)</sup> | Temperature Under Bias               | -55 to +125             | °C   |
| T <sub>STG</sub>                 | Storage Temperature                  | -65 to +150             | °C   |
| T <sub>JN</sub>                  | Junction Temperature                 | +150                    | °C   |
| I <sub>OUT</sub>                 | DC Output Current                    | 50                      | mA   |

5623 tbl 06

**NOTES:**

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V<sub>TERM</sub> must not exceed V<sub>DD</sub> + 150mV for more than 25% of the cycle time or 4ns maximum, and is limited to  $\leq$  20mA for the period of V<sub>TERM</sub>  $\geq$  V<sub>DD</sub> + 150mV.
3. Ambient Temperature Under Bias. No AC Conditions. Chip Deselected.

## Recommended DC Operating Conditions with V<sub>DDQ</sub> at 3.3V

| Symbol           | Parameter                                                    | Min.                | Typ. | Max.                                    | Unit |
|------------------|--------------------------------------------------------------|---------------------|------|-----------------------------------------|------|
| V <sub>DD</sub>  | Core Supply Voltage                                          | 3.15                | 3.3  | 3.45                                    | V    |
| V <sub>DDQ</sub> | I/O Supply Voltage <sup>(2)</sup>                            | 3.15                | 3.3  | 3.45                                    | V    |
| V <sub>SS</sub>  | Ground                                                       | 0                   | 0    | 0                                       | V    |
| V <sub>IH</sub>  | Input High Voltage (Address & Control Inputs) <sup>(3)</sup> | 2.0                 | —    | V <sub>DDQ</sub> + 150mV <sup>(2)</sup> | V    |
| V <sub>IH</sub>  | Input High Voltage - I/O <sup>(3)</sup>                      | 2.0                 | —    | V <sub>DDQ</sub> + 150mV <sup>(2)</sup> | V    |
| V <sub>IL</sub>  | Input Low Voltage                                            | -0.3 <sup>(1)</sup> | —    | 0.8                                     | V    |

5623 tbl 05b

**NOTES:**

1. Undershoot of V<sub>IL</sub>  $\geq$  -1.5V for pulse width less than 10ns is allowed.
2. V<sub>TERM</sub> must not exceed V<sub>DDQ</sub> + 150mV.
3. To select operation at 3.3V levels on the I/Os and controls of a given port, the OPT pin for that port must be set to V<sub>IH</sub> (3.3V), and V<sub>DDQX</sub> for that port must be supplied as indicated above.

## Capacitance<sup>(1)</sup> ( $T_A = +25^\circ\text{C}$ , $F = 1.0\text{MHz}$ )

| Symbol          | Parameter          | Conditions <sup>(2)</sup> | Max. | Unit |
|-----------------|--------------------|---------------------------|------|------|
| $C_{IN}$        | Input Capacitance  | $V_{IN} = 3\text{dV}$     | 8    | pF   |
| $C_{OUT}^{(3)}$ | Output Capacitance | $V_{OUT} = 3\text{dV}$    | 10.5 | pF   |

5623 tbl 07

### NOTES:

- These parameters are determined by device characterization, but are not production tested.
- 3dV references the interpolated capacitance when the input and output switch from 0V to 3V or from 3V to 0V.
- $C_{OUT}$  also references  $C_{IO}$ .

## DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range ( $V_{DD} = 3.3\text{V} \pm 150\text{mV}$ )

| Symbol                 | Parameter                             | Test Conditions                                                                       | 70V3319/99S |      | Unit          |
|------------------------|---------------------------------------|---------------------------------------------------------------------------------------|-------------|------|---------------|
|                        |                                       |                                                                                       | Min.        | Max. |               |
| $ I_{LI} $             | Input Leakage Current <sup>(1)</sup>  | $V_{DDQ} = \text{Max.}, V_{IN} = 0\text{V to } V_{DDQ}$                               | —           | 10   | $\mu\text{A}$ |
| $ I_{LO} $             | Output Leakage Current <sup>(1)</sup> | $\overline{CE}_0 = V_{IH} \text{ or } CE_1 = V_{IL}, V_{OUT} = 0\text{V to } V_{DDQ}$ | —           | 10   | $\mu\text{A}$ |
| $V_{OL} (3.3\text{V})$ | Output Low Voltage <sup>(2)</sup>     | $I_{OL} = +4\text{mA}, V_{DDQ} = \text{Min.}$                                         | —           | 0.4  | V             |
| $V_{OH} (3.3\text{V})$ | Output High Voltage <sup>(2)</sup>    | $I_{OH} = -4\text{mA}, V_{DDQ} = \text{Min.}$                                         | 2.4         | —    | V             |
| $V_{OL} (2.5\text{V})$ | Output Low Voltage <sup>(2)</sup>     | $I_{OL} = +2\text{mA}, V_{DDQ} = \text{Min.}$                                         | —           | 0.4  | V             |
| $V_{OH} (2.5\text{V})$ | Output High Voltage <sup>(2)</sup>    | $I_{OH} = -2\text{mA}, V_{DDQ} = \text{Min.}$                                         | 2.0         | —    | V             |

5623 tbl 08

### NOTE:

- At  $V_{DD} \leq 2.0\text{V}$  leakages are undefined.
- $V_{DDQ}$  is selectable (3.3V/2.5V) via OPT pins. Refer to p.5 for details.



# DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range<sup>(3)</sup> ( $V_{DD} = 3.3V \pm 150mV$ )

| Symbol | Parameter                                             | Test Condition                                                                                                                                                                            | Version | 70V3319/99S166<br>Com'l Only |      | 70V3319/99S133<br>Com'l & Ind |      | Unit |
|--------|-------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|------------------------------|------|-------------------------------|------|------|
|        |                                                       |                                                                                                                                                                                           |         | Typ. <sup>(4)</sup>          | Max. | Typ. <sup>(4)</sup>           | Max. |      |
| IDD    | Dynamic Operating Current (Both Ports Active)         | $\overline{CE}_L$ and $\overline{CE}_R = V_{IL}$ ,<br>Outputs Disabled,<br>$f = f_{MAX}^{(1)}$                                                                                            | COM'L S | 370                          | 500  | 320                           | 400  | mA   |
|        |                                                       |                                                                                                                                                                                           | IND S   | —                            | —    | 320                           | 480  |      |
| ISB1   | Standby Current (Both Ports - TTL Level Inputs)       | $\overline{CE}_L = \overline{CE}_R = V_{IH}$ ,<br>Outputs Disabled,<br>$f = f_{MAX}^{(1)}$                                                                                                | COM'L S | 125                          | 200  | 115                           | 160  | mA   |
|        |                                                       |                                                                                                                                                                                           | IND S   | —                            | —    | 115                           | 195  |      |
| ISB2   | Standby Current (One Port - TTL Level Inputs)         | $\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(5)}$<br>Active Port Outputs Disabled,<br>$f = f_{MAX}^{(1)}$                                                                 | COM'L S | 250                          | 350  | 220                           | 290  | mA   |
|        |                                                       |                                                                                                                                                                                           | IND S   | —                            | —    | 220                           | 350  |      |
| ISB3   | Full Standby Current (Both Ports - CMOS Level Inputs) | Both Ports Outputs Disabled<br>$\overline{CE}_L$ and $\overline{CE}_R \geq V_{DDQ} - 0.2V$ ,<br>$V_{IN} \geq V_{DDQ} - 0.2V$<br>or $V_{IN} \leq 0.2V$ , $f = 0^{(2)}$                     | COM'L S | 15                           | 30   | 15                            | 30   | mA   |
|        |                                                       |                                                                                                                                                                                           | IND S   | —                            | —    | 15                            | 40   |      |
| ISB4   | Full Standby Current (One Port - CMOS Level Inputs)   | $\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{DDQ} - 0.2V^{(5)}$<br>$V_{IN} \geq V_{DDQ} - 0.2V$ or $V_{IN} \leq 0.2V$<br>Active Port, Outputs Disabled, $f = f_{MAX}^{(1)}$ | COM'L S | 250                          | 350  | 220                           | 290  | mA   |
|        |                                                       |                                                                                                                                                                                           | IND S   | —                            | —    | 220                           | 350  |      |

5623 tbl 09

## NOTES:

- At  $f = f_{MAX}$ , address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of  $1/t_{CYC}$ , using "AC TEST CONDITIONS" at input levels of GND to 3V.
- $f = 0$  means no address, clock, or control lines change. Applies only to input at CMOS level standby.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- $V_{DD} = 3.3V$ ,  $T_A = 25^\circ C$  for Typ, and are not production tested.  $I_{DD} pc(f=0) = 120mA$  (Typ).
- $\overline{CE}_X = V_{IL}$  means  $\overline{CE}_{0X} = V_{IL}$  and  $CE_{1X} = V_{IH}$   
 $\overline{CE}_X = V_{IH}$  means  $\overline{CE}_{0X} = V_{IH}$  or  $CE_{1X} = V_{IL}$   
 $\overline{CE}_X \leq 0.2V$  means  $\overline{CE}_{0X} \leq 0.2V$  and  $CE_{1X} \geq V_{DDQ} - 0.2V$   
 $\overline{CE}_X \geq V_{DDQ} - 0.2V$  means  $\overline{CE}_{0X} \geq V_{DDQ} - 0.2V$  or  $CE_{1X} \leq 0.2V$   
"X" represents "L" for left port or "R" for right port.

# AC Test Conditions (V<sub>DDQ</sub> = 3.3V/2.5V)

|                                         |                         |
|-----------------------------------------|-------------------------|
| Input Pulse Levels (Address & Controls) | GND to 3.0V/GND to 2.4V |
| Input Pulse Levels (I/Os)               | GND to 3.0V/GND to 2.4V |
| Input Rise/Fall Times                   | 2ns                     |
| Input Timing Reference Levels           | 1.5V/1.25V              |
| Output Reference Levels                 | 1.5V/1.25V              |
| Output Load                             | Figures 1 and 2         |

5623 tbl 10

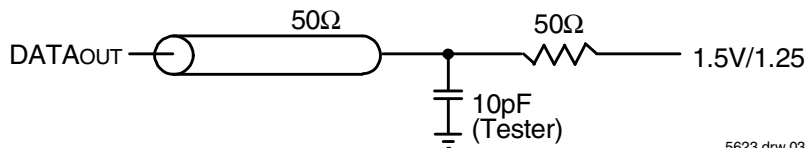
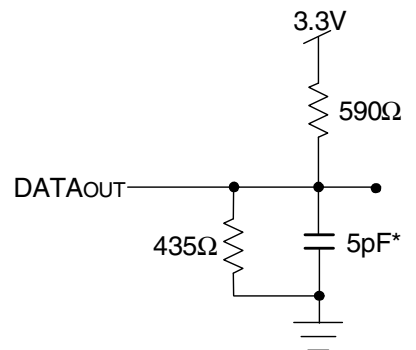
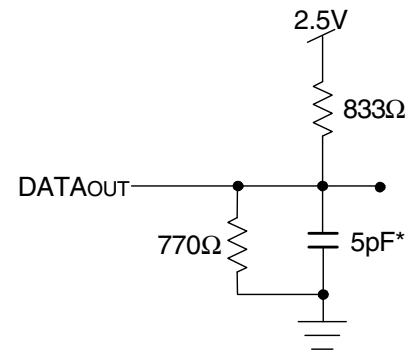


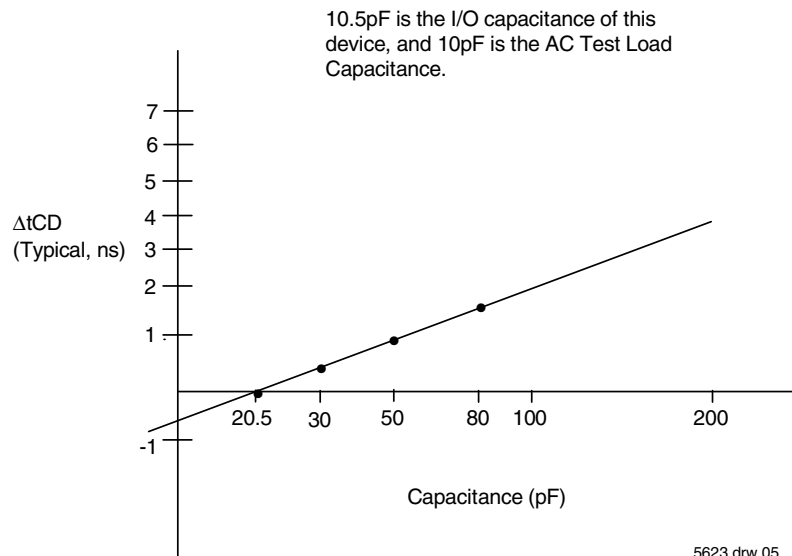
Figure 1. AC Output Test load.

5623 drw 03



5623 drw 04

Figure 2. Output Test Load  
(For t<sub>CKLZ</sub>, t<sub>CKHZ</sub>, t<sub>OLZ</sub>, and t<sub>OHZ</sub>).  
\*Including scope and jig.



5623 drw 05

Figure 3. Typical Output Derating (Lumped Capacitive Load).

# AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing)<sup>(2,3)</sup> ( $V_{DD} = 3.3V \pm 150mV$ , $T_A = 0^{\circ}C$ to $+70^{\circ}C$ )

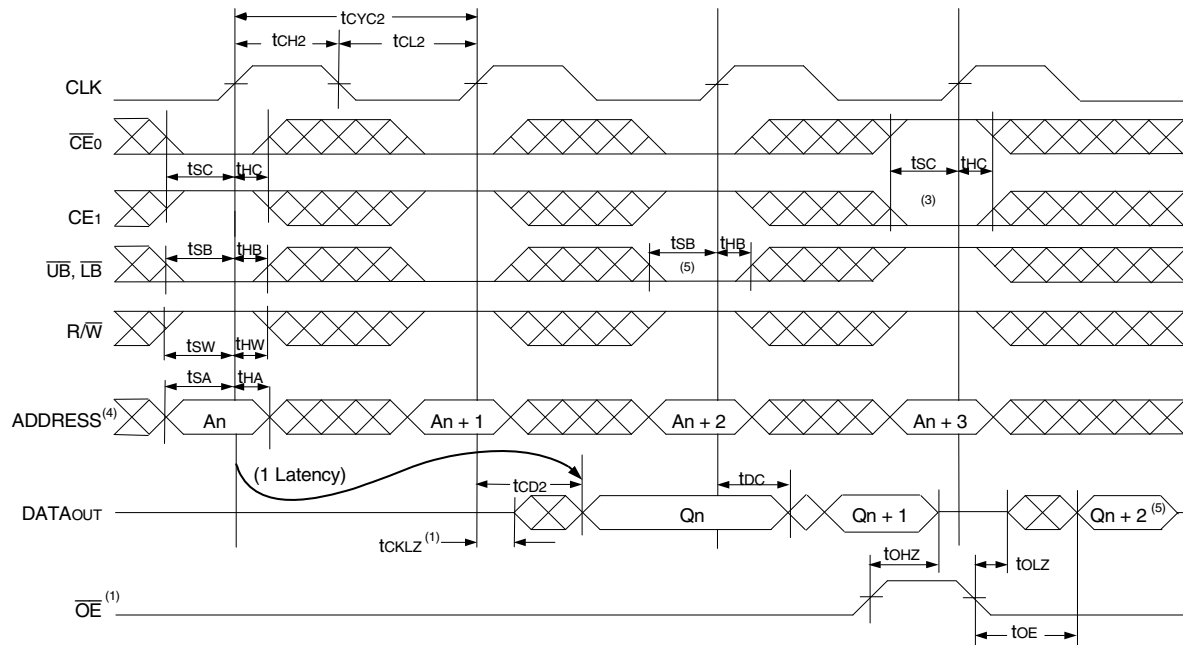
| Symbol                    | Parameter                                         | 70V3319/99S166<br>Com'l Only |      | 70V3319/99S133<br>Com'l & Ind |      | Unit |
|---------------------------|---------------------------------------------------|------------------------------|------|-------------------------------|------|------|
|                           |                                                   | Min.                         | Max. | Min.                          | Max. |      |
| t <sub>CYC1</sub>         | Clock Cycle Time (Flow-Through) <sup>(1)</sup>    | 20                           | —    | 25                            | —    | ns   |
| t <sub>CYC2</sub>         | Clock Cycle Time (Pipelined) <sup>(1)</sup>       | 6                            | —    | 7.5                           | —    | ns   |
| t <sub>CH1</sub>          | Clock High Time (Flow-Through) <sup>(1)</sup>     | 6                            | —    | 7                             | —    | ns   |
| t <sub>CL1</sub>          | Clock Low Time (Flow-Through) <sup>(1)</sup>      | 6                            | —    | 7                             | —    | ns   |
| t <sub>CH2</sub>          | Clock High Time (Pipelined) <sup>(2)</sup>        | 2.1                          | —    | 2.6                           | —    | ns   |
| t <sub>CL2</sub>          | Clock Low Time (Pipelined) <sup>(1)</sup>         | 2.1                          | —    | 2.6                           | —    | ns   |
| t <sub>SA</sub>           | Address Setup Time                                | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HA</sub>           | Address Hold Time                                 | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SC</sub>           | Chip Enable Setup Time                            | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HC</sub>           | Chip Enable Hold Time                             | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SB</sub>           | Byte Enable Setup Time                            | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HB</sub>           | Byte Enable Hold Time                             | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SW</sub>           | R/W Setup Time                                    | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HW</sub>           | R/W Hold Time                                     | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SD</sub>           | Input Data Setup Time                             | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HD</sub>           | Input Data Hold Time                              | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SAD</sub>          | $\overline{ADS}$ Setup Time                       | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HAD</sub>          | $\overline{ADS}$ Hold Time                        | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SCN</sub>          | $\overline{CNTEN}$ Setup Time                     | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HCN</sub>          | $\overline{CNTEN}$ Hold Time                      | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>SRPT</sub>         | $\overline{REPEAT}$ Setup Time                    | 1.7                          | —    | 1.8                           | —    | ns   |
| t <sub>HRPT</sub>         | $\overline{REPEAT}$ Hold Time                     | 0.5                          | —    | 0.5                           | —    | ns   |
| t <sub>OE</sub>           | Output Enable to Data Valid                       | —                            | 4.0  | —                             | 4.2  | ns   |
| t <sub>OLZ</sub>          | Output Enable to Output Low-Z                     | 1                            | —    | 1                             | —    | ns   |
| t <sub>OHZ</sub>          | Output Enable to Output High-Z                    | 1                            | 3.6  | 1                             | 4.2  | ns   |
| t <sub>CD1</sub>          | Clock to Data Valid (Flow-Through) <sup>(1)</sup> | —                            | 12   | —                             | 15   | ns   |
| t <sub>CD2</sub>          | Clock to Data Valid (Pipelined) <sup>(1)</sup>    | —                            | 3.6  | —                             | 4.2  | ns   |
| t <sub>DC</sub>           | Data Output Hold After Clock High                 | 1                            | —    | 1                             | —    | ns   |
| t <sub>CKHZ</sub>         | Clock High to Output High-Z                       | 1                            | 3    | 1                             | 3    | ns   |
| t <sub>CKLZ</sub>         | Clock High to Output Low-Z                        | 1                            | —    | 1                             | —    | ns   |
| <b>Port-to-Port Delay</b> |                                                   |                              |      |                               |      |      |
| t <sub>CO</sub>           | Clock-to-Clock Offset                             | 5                            | —    | 6                             | —    | ns   |

**NOTES:**

5623 tbl 11

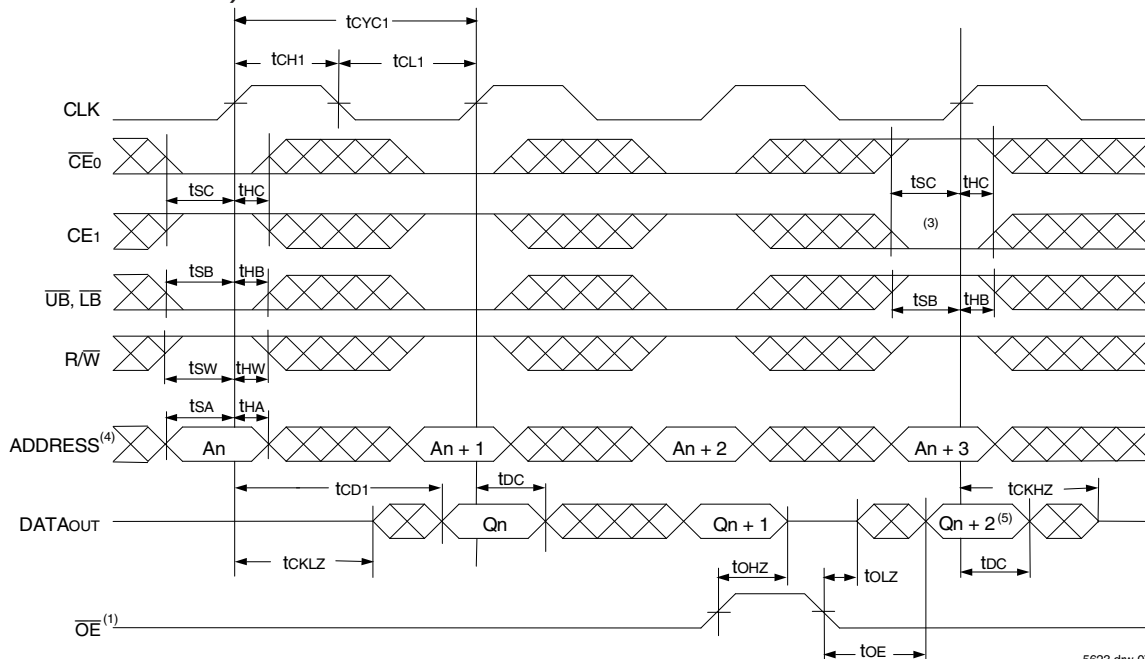
- The Pipelined output parameters (t<sub>CYC2</sub>, t<sub>CD2</sub>) apply to either or both left and right ports when  $\overline{FT}/PIPE = V_{IH}$ . Flow-through parameters (t<sub>CYC1</sub>, t<sub>CD1</sub>) apply when  $\overline{FT}/PIPE = V_{IL}$  for that port.
- All input signals are synchronous with respect to the clock except for the asynchronous Output Enable ( $\overline{OE}$ ) and  $\overline{FT}/PIPE$ .  $\overline{FT}/PIPE$  should be treated as a DC signal, i.e. steady state during operation.
- These values are valid for either level of  $V_{DDQ}$  (3.3V/2.5V). See page 5 for details on selecting the desired operating voltage levels for each port.

# Timing Waveform of Read Cycle for Pipelined Operation ( $\overline{\text{FT}}/\text{PIPE}^{\text{'X'}} = V_{\text{IH}}$ )<sup>(2)</sup>



5623 drw 06

# Timing Waveform of Read Cycle for Flow-through Output ( $\overline{\text{FT}}/\text{PIPE}^{\text{'X'}} = V_{\text{IL}}$ )<sup>(2,6)</sup>

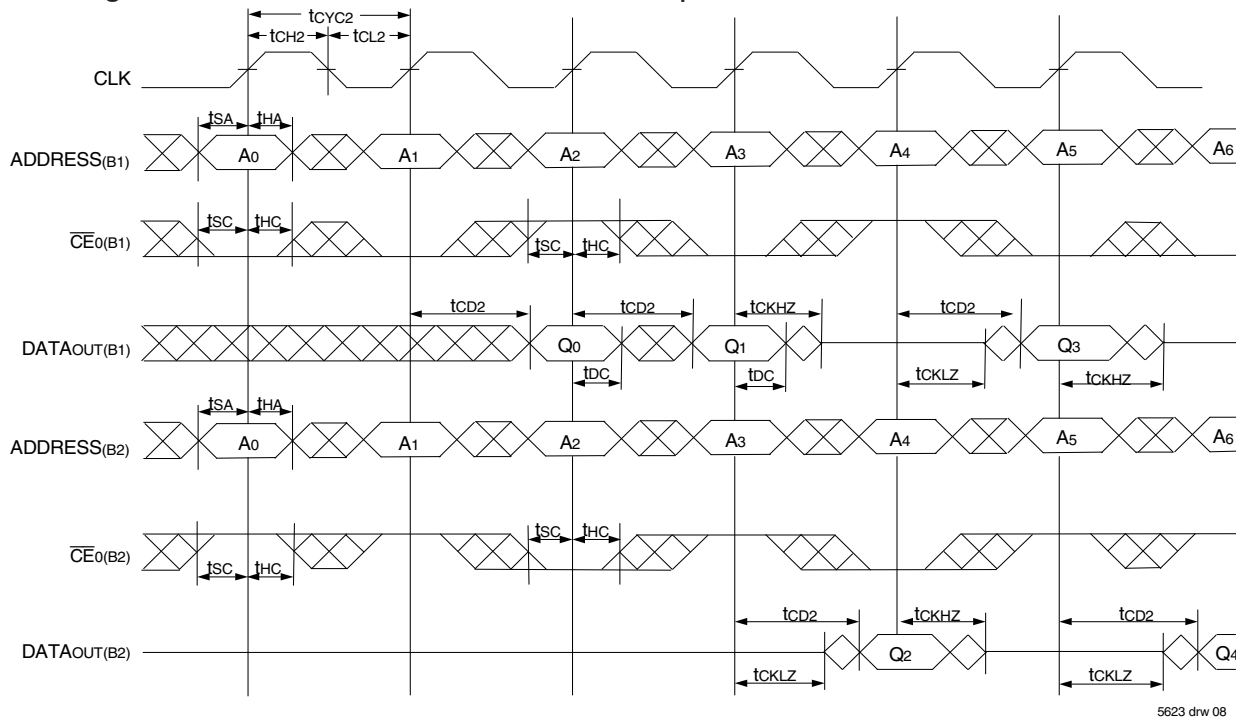


5623 drw 07

## NOTES:

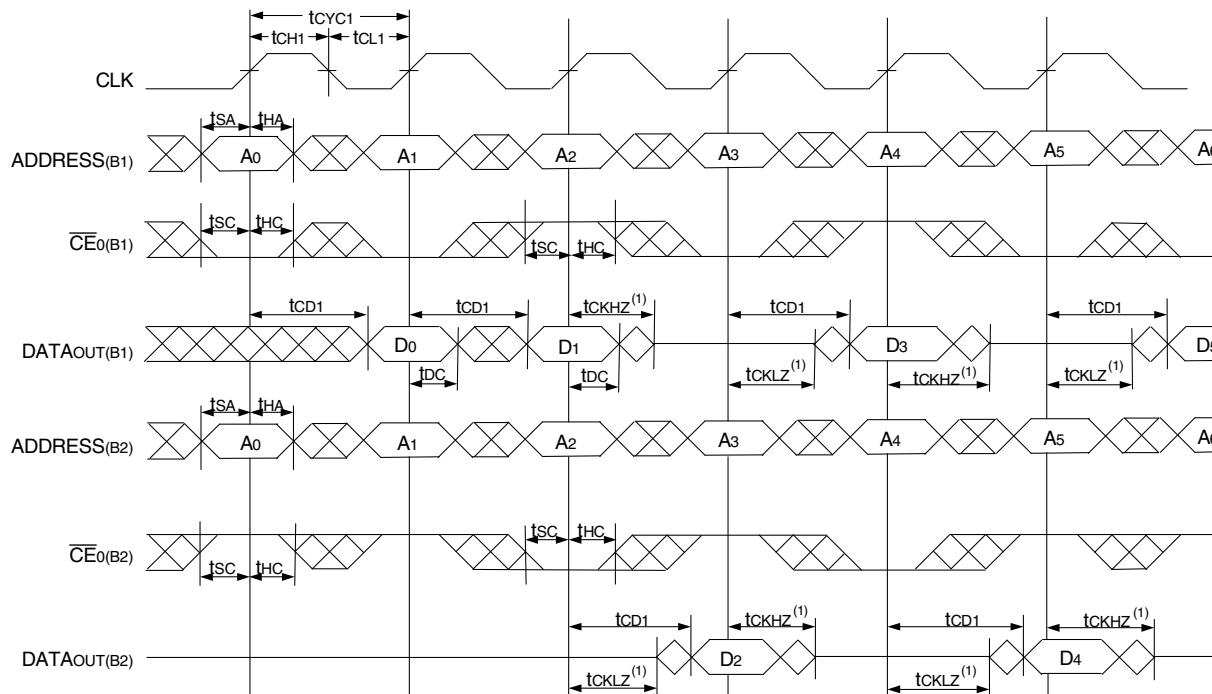
- $\overline{\text{OE}}$  is asynchronously controlled; all other inputs are synchronous to the rising clock edge.
- $\text{ADS} = V_{\text{IL}}$ ,  $\text{CNTEN}$  and  $\text{REPEAT} = V_{\text{IH}}$ .
- The output is disabled (High-Impedance state) by  $\overline{\text{CE}}_0 = V_{\text{IH}}$ ,  $\text{CE}_1 = V_{\text{IL}}$ ,  $\overline{\text{UB}}$ ,  $\overline{\text{LB}} = V_{\text{IH}}$  following the next rising edge of the clock. Refer to Truth Table 1.
- Addresses do not have to be accessed sequentially since  $\text{ADS} = V_{\text{IL}}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
- If  $\overline{\text{UB}}$ ,  $\overline{\text{LB}}$  was HIGH, then the appropriate Byte of DATAout for  $Q_{n+2}$  would be disabled (High-Impedance state).
- "x" denotes Left or Right port. The diagram is with respect to that port.

# Timing Waveform of a Multi-Device Pipelined Read<sup>(1,2)</sup>



5623 drw 08

# Timing Waveform of a Multi-Device Flow-Through Read<sup>(1,2)</sup>

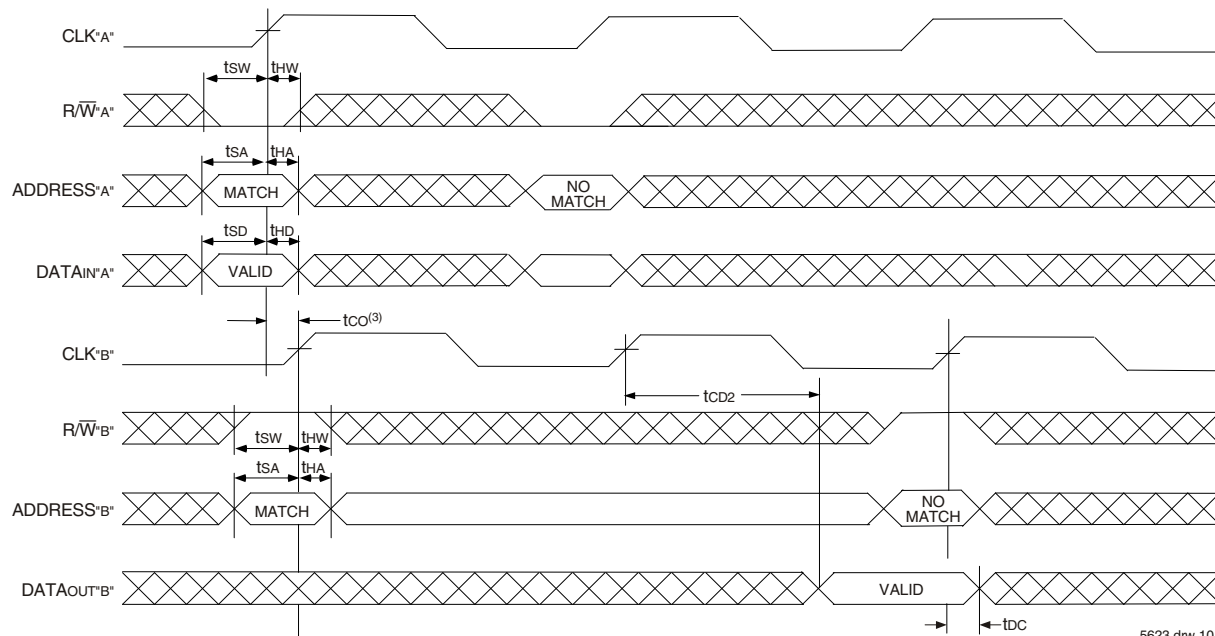


5623 drw 09

## NOTES:

1. B1 Represents Device #1; B2 Represents Device #2. Each Device consists of one IDT70V3319/99 for this waveform, and are setup for depth expansion in this example. ADDRESS(B1) = ADDRESS(B2) in this situation.
2. UB, LB, OE, and ADS = VIL; CE1(B1), CE1(B2), R/W, CNTEN, and REPEAT = VIH.

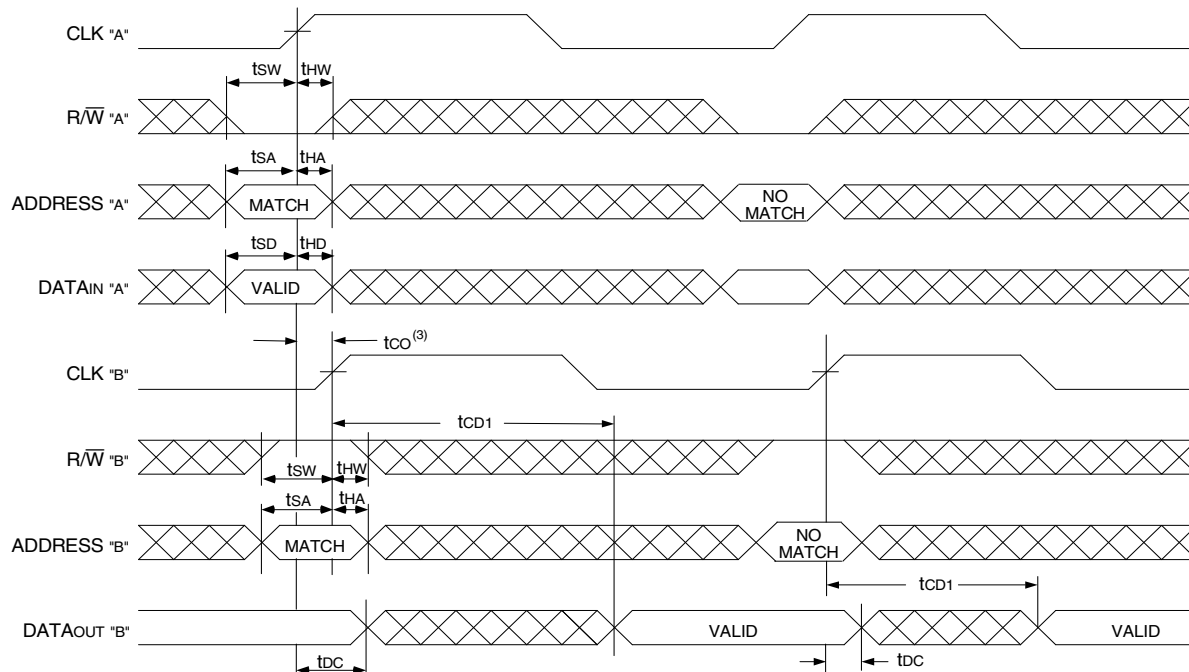
## Timing Waveform of Left Port Write to Pipelined Right Port Read<sup>(1,2,4)</sup>



### NOTES:

1.  $\overline{CE_0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE_1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ .
2.  $\overline{OE} = V_{IL}$  for Port "B", which is being read from.  $\overline{OE} = V_{IH}$  for Port "A", which is being written to.
3. If  $t_{CO} \leq$  minimum specified, then data from Port "B" read is not valid until following Port "B" clock cycle (ie, time from write to valid read on opposite port will be  $t_{CO} + 2 t_{CYC2} + t_{CD2}$ ). If  $t_{CO} >$  minimum, then data from Port "B" read is available on first Port "B" clock cycle (ie, time from write to valid read on opposite port will be  $t_{CO} + t_{CYC2} + t_{CD2}$ ).
4. All timing is the same for Left and Right ports. Port "A" may be either Left or Right port. Port "B" is the opposite of Port "A"

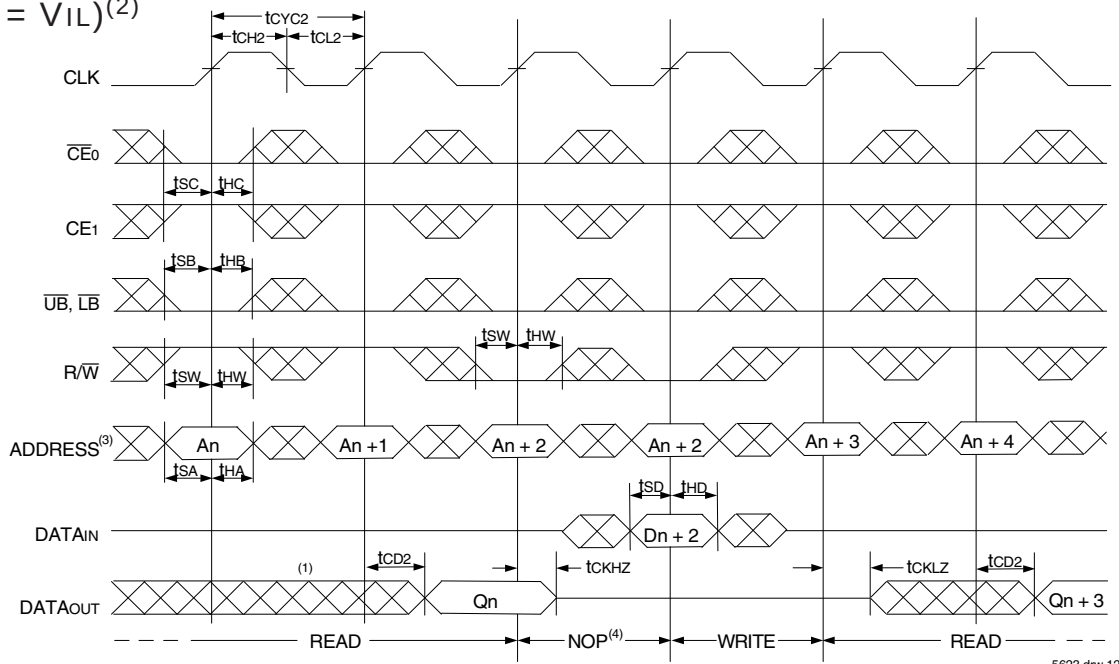
## Timing Waveform with Port-to-Port Flow-Through Read<sup>(1,2,4)</sup>



### NOTES:

1.  $\overline{CE_0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE_1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ .
2.  $\overline{OE} = V_{IL}$  for the Right Port, which is being read from.  $\overline{OE} = V_{IH}$  for the Left Port, which is being written to.
3. If  $t_{CO} \leq$  minimum specified, then data from Port "B" read is not valid until following Port "B" clock cycle (i.e., time from write to valid read on opposite port will be  $t_{CO} + t_{CYC} + t_{CD1}$ ). If  $t_{CO} >$  minimum, then data from Port "B" read is available on first Port "B" clock cycle (i.e., time from write to valid read on opposite port will be  $t_{CO} + t_{CD1}$ ).
4. All timing is the same for both left and right ports. Port "A" may be either left or right port. Port "B" is the opposite of Port "A".

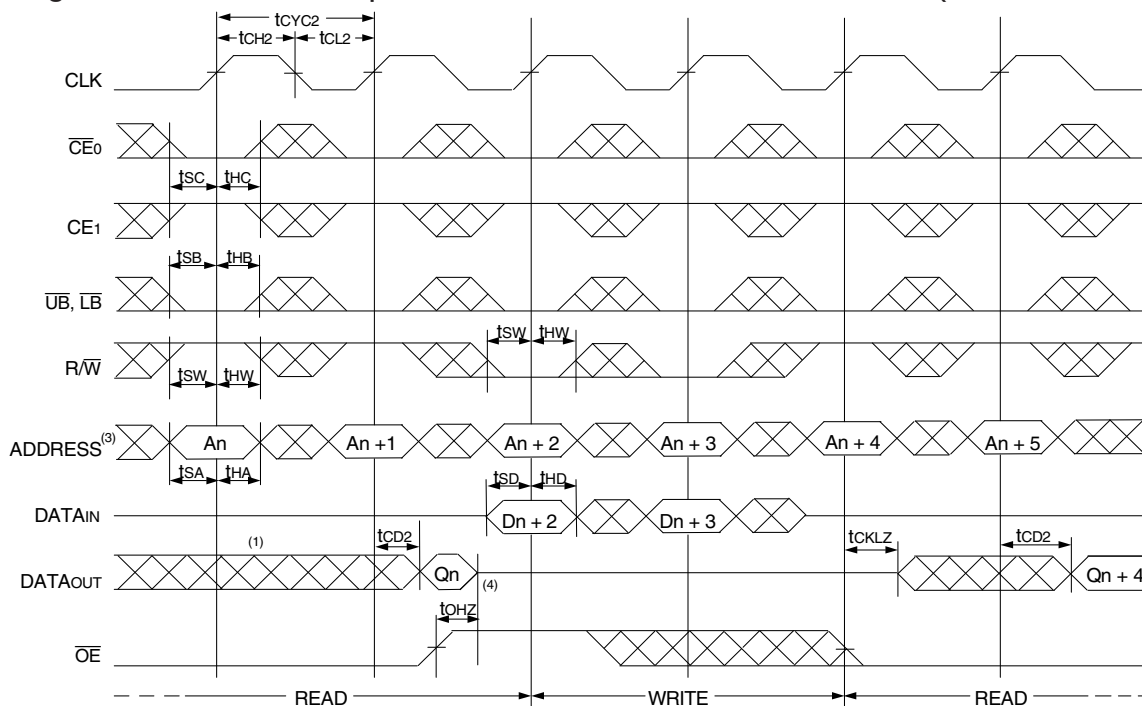
## Timing Waveform of Pipelined Read-to-Write-to-Read ( $\overline{OE} = V_{IL}$ )<sup>(2)</sup>



### NOTES:

1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
2.  $\overline{CE0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ . "NOP" is "No Operation".
3. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
4. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be rewritten to guarantee data integrity.

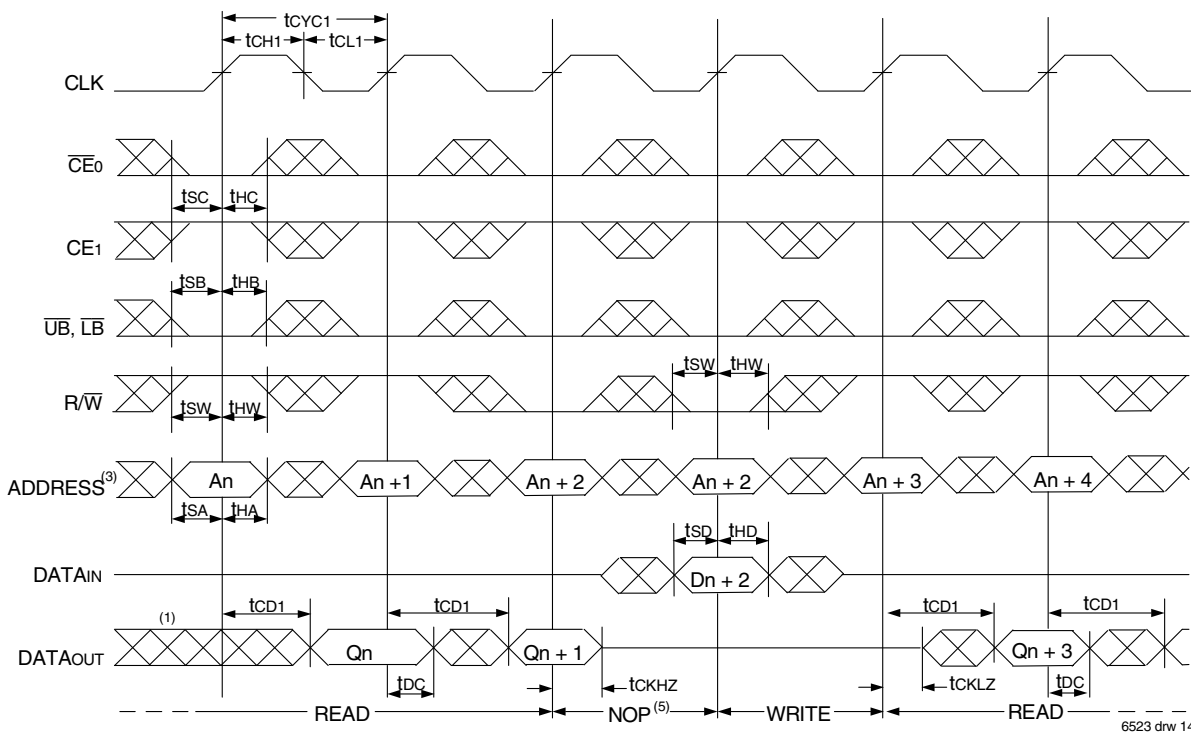
## Timing Waveform of Pipelined Read-to-Write-to-Read ( $\overline{OE}$ Controlled)<sup>(2)</sup>



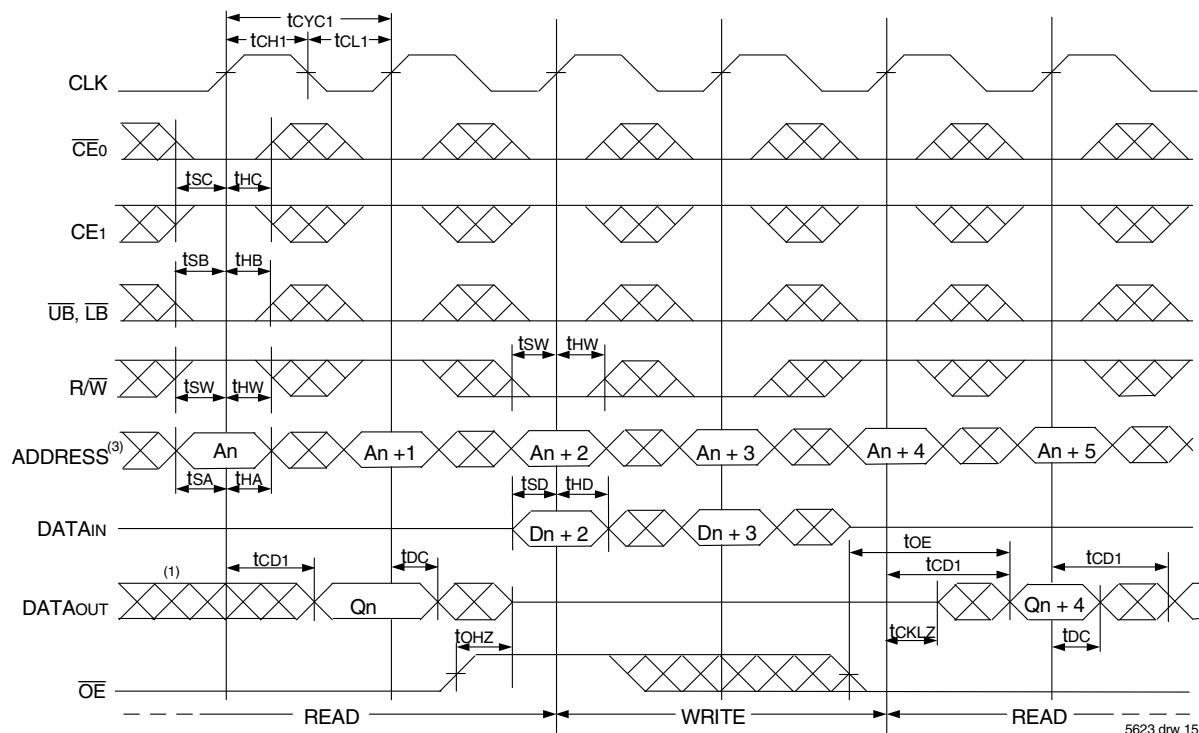
### NOTES:

1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
2.  $\overline{CE0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ .
3. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
4. This timing does not meet requirements for fastest speed grade. This waveform indicates how logically it could be done if timing so allows.

# Timing Waveform of Flow-Through Read-to-Write-to-Read ( $\overline{OE} = V_{IL}$ )<sup>(2)</sup>



# Timing Waveform of Flow-Through Read-to-Write-to-Read ( $\overline{OE}$ Controlled)<sup>(2)</sup>

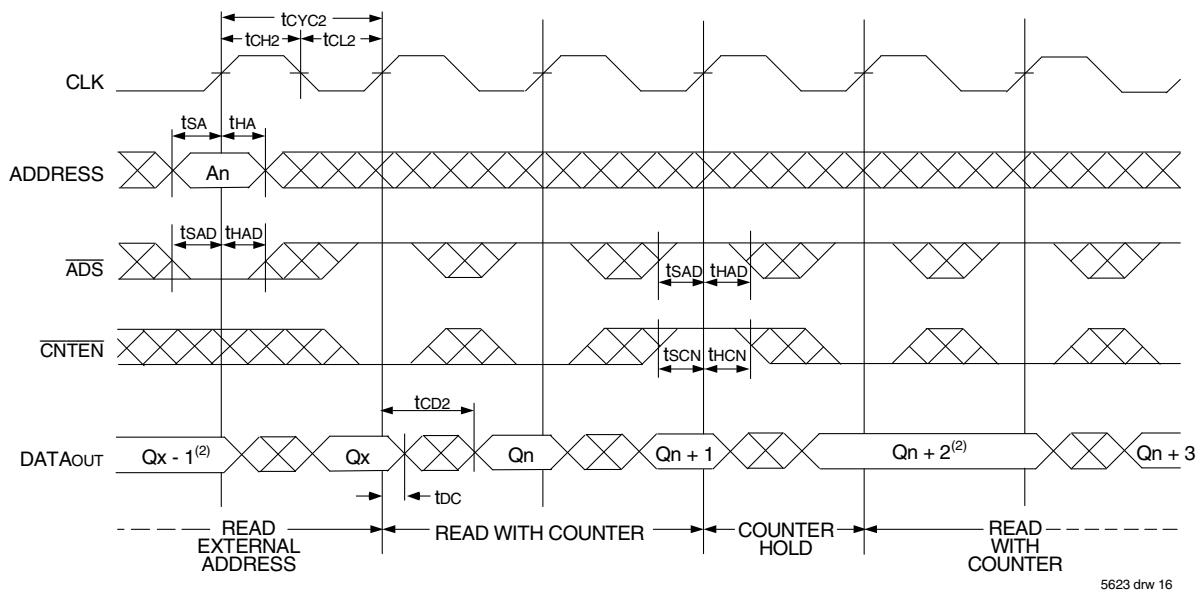


## NOTES:

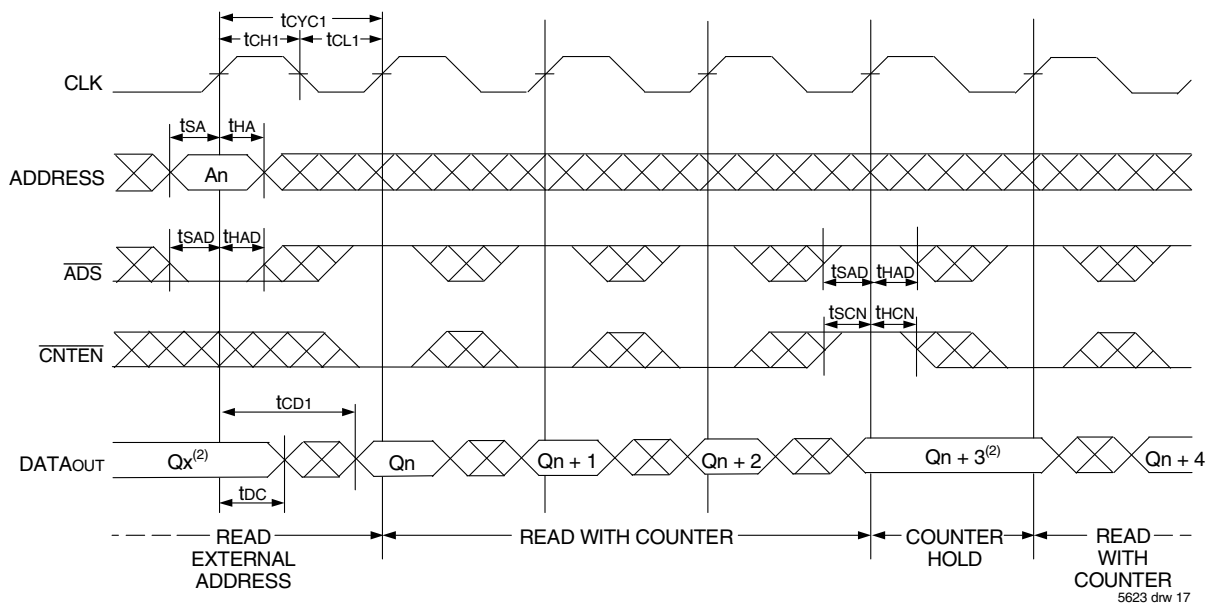
1. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
2.  $\overline{CE0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $\overline{ADS} = V_{IL}$ ;  $\overline{CE1}$ ,  $\overline{CNTEN}$ , and  $\overline{REPEAT} = V_{IH}$ .
3. Addresses do not have to be accessed sequentially since  $\overline{ADS} = V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
4. "NOP" is "No Operation." Data in memory at the selected address may be corrupted and should be rewritten to guarantee data integrity.



# Timing Waveform of Pipelined Read with Address Counter Advance<sup>(1)</sup>



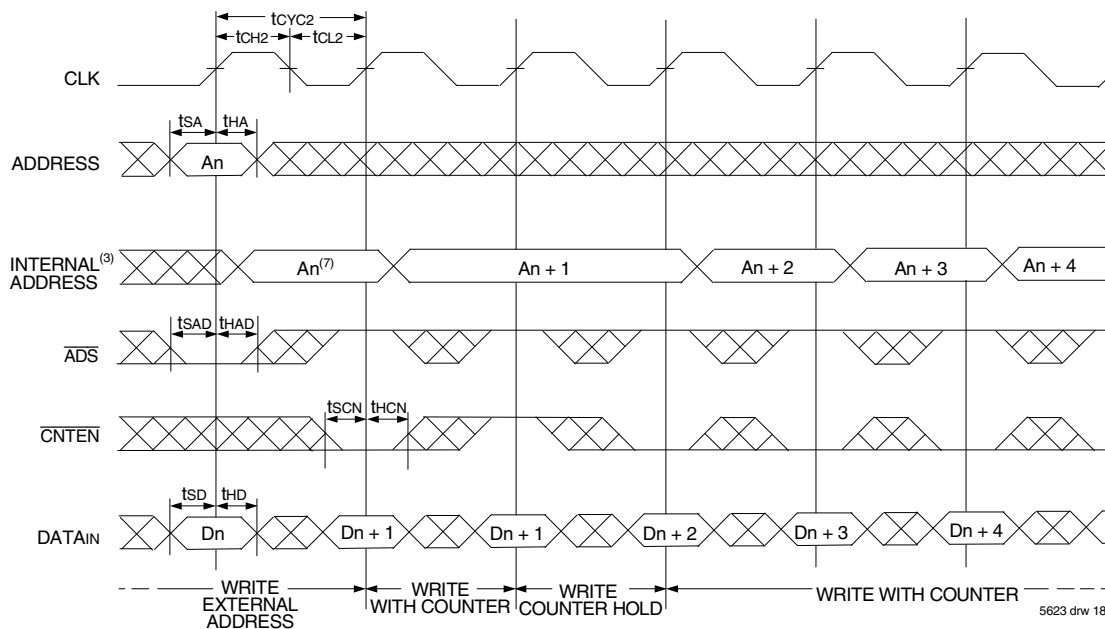
# Timing Waveform of Flow-Through Read with Address Counter Advance<sup>(1)</sup>



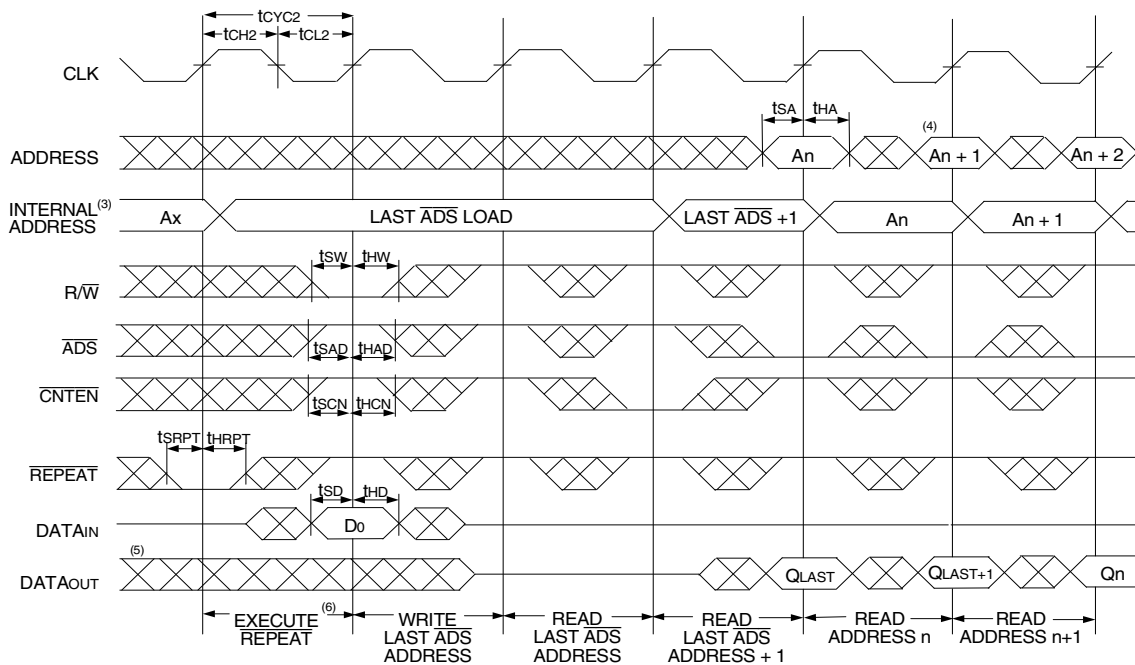
## NOTES:

1.  $\overline{CE}_0$ ,  $\overline{OE}$ ,  $\overline{UB}$ ,  $\overline{LB}$  =  $V_{IL}$ ;  $CE_1$ ,  $R/\overline{W}$ , and  $\overline{REPEAT}$  =  $V_{IH}$ .
2. If there is no address change via  $\overline{ADS} = V_{IL}$  (loading a new address) or  $\overline{CNTEN} = V_{IL}$  (advancing the address), i.e.  $\overline{ADS} = V_{IH}$  and  $\overline{CNTEN} = V_{IH}$ , then the data output remains constant for subsequent clocks.

## Timing Waveform of Write with Address Counter Advance (Flow-through or Pipelined Inputs)<sup>(1)</sup>



## Timing Waveform of Counter Repeat<sup>(2)</sup>



### NOTES:

1.  $\overline{CE_0}$ ,  $\overline{UB}$ ,  $\overline{LB}$ , and  $R/\overline{W}$  =  $V_{IL}$ ;  $CE_1$  and  $\overline{REPEAT}$  =  $V_{IH}$ .
2.  $\overline{CE_0}$ ,  $\overline{UB}$ ,  $\overline{LB}$  =  $V_{IL}$ ;  $CE_1$  =  $V_{IH}$ .
3. The "Internal Address" is equal to the "External Address" when  $\overline{ADS}$  =  $V_{IL}$  and equals the counter output when  $\overline{ADS}$  =  $V_{IH}$ .
4. Addresses do not have to be accessed sequentially since  $\overline{ADS}$  =  $V_{IL}$  constantly loads the address on the rising edge of the CLK; numbers are for reference use only.
5. Output state (High, Low, or High-impedance) is determined by the previous cycle control signals.
6. No dead cycle exists during REPEAT operation. A READ or WRITE cycle may be coincidental with the counter REPEAT cycle: Address loaded by last valid  $\overline{ADS}$  load will be accessed. Extra cycles are shown here simply for clarification. For more information on REPEAT function refer to Truth Table II.
7.  $\overline{CNTEN}$  =  $V_{IL}$  advances Internal Address from 'An' to 'An + 1'. The transition shown indicates the time required for the counter to advance. The 'An + 1' Address is written to during this cycle.

## Functional Description

The IDT70V3319/99 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide minimal set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal, however, the self-timed internal write pulse is independent of the LOW to HIGH transition of the clock signal.

An asynchronous output enable is provided to ease asynchronous bus interfacing. Counter enable inputs are also provided to stall the operation of the address counters for fast interleaved memory applications.

A HIGH on  $\overline{CE_0}$  or a LOW on  $CE_1$  for one clock cycle will power down the internal circuitry to reduce static power consumption. Multiple chip enables allow easier banking of multiple IDT70V3319/99s for depth expansion configurations. Two cycles are required with  $\overline{CE_0}$  LOW and  $CE_1$  HIGH to reactivate the outputs.

## Depth and Width Expansion

The IDT70V3319/99 features dual chip enables (refer to Truth Table I) in order to facilitate rapid and simple depth expansion with no requirements for external logic. Figure 4 illustrates how to control the various chip enables in order to expand two devices in depth.

The IDT70V3319/99 can also be used in applications requiring expanded width, as indicated in Figure 4. Through combining the control signals, the devices can be grouped as necessary to accommodate applications needing 36-bits or wider.

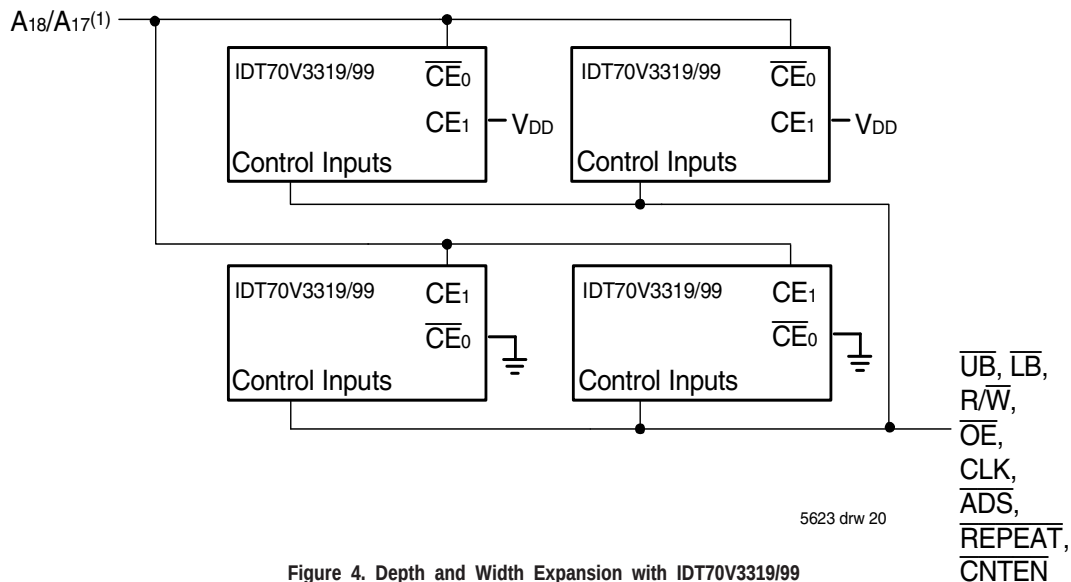
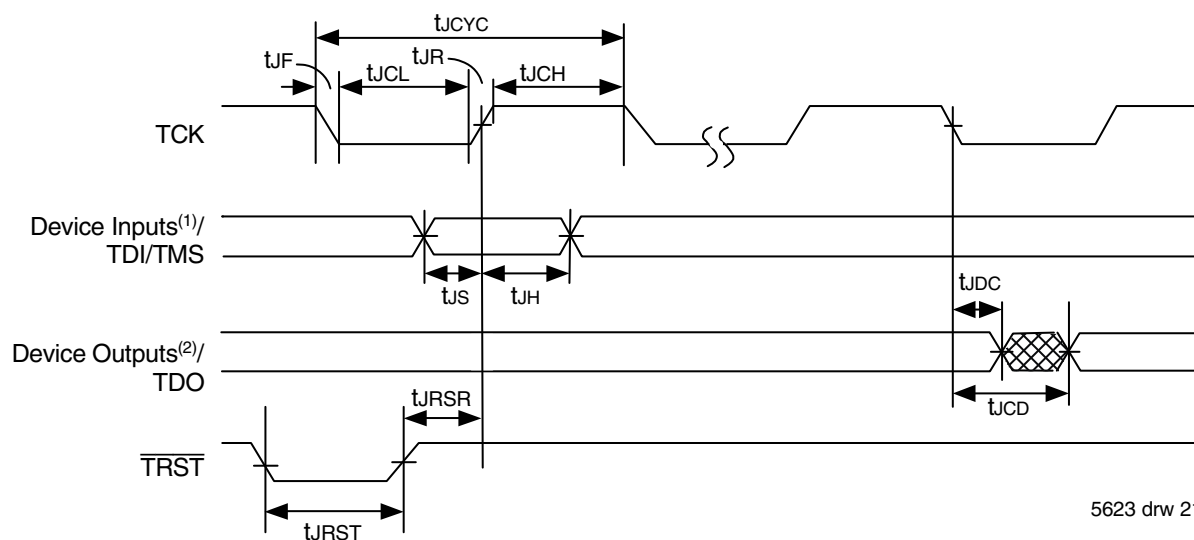


Figure 4. Depth and Width Expansion with IDT70V3319/99

### NOTE:

1. A17 is for IDT70V3319, A16 is for IDT70V3399.

# JTAG Timing Specifications



## NOTES:

1. Device inputs = All device inputs except TDI, TMS, and TRST.
2. Device outputs = All device outputs except TDO.

## JTAG AC Electrical Characteristics<sup>(1,2,3,4)</sup>

| Symbol            | Parameter               | 70V3319/99 |                  |       |
|-------------------|-------------------------|------------|------------------|-------|
|                   |                         | Min.       | Max.             | Units |
| t <sub>JCYC</sub> | JTAG Clock Input Period | 100        | —                | ns    |
| t <sub>JCH</sub>  | JTAG Clock HIGH         | 40         | —                | ns    |
| t <sub>JCL</sub>  | JTAG Clock Low          | 40         | —                | ns    |
| t <sub>JR</sub>   | JTAG Clock Rise Time    | —          | 3 <sup>(1)</sup> | ns    |
| t <sub>JF</sub>   | JTAG Clock Fall Time    | —          | 3 <sup>(1)</sup> | ns    |
| t <sub>JRST</sub> | JTAG Reset              | 50         | —                | ns    |
| t <sub>JRSR</sub> | JTAG Reset Recovery     | 50         | —                | ns    |
| t <sub>JCD</sub>  | JTAG Data Output        | —          | 25               | ns    |
| t <sub>JDC</sub>  | JTAG Data Output Hold   | 0          | —                | ns    |
| t <sub>JS</sub>   | JTAG Setup              | 15         | —                | ns    |
| t <sub>JH</sub>   | JTAG Hold               | 15         | —                | ns    |

5623 tbl 12

## NOTES:

1. Guaranteed by design.
2. 30pF loading on external output signals.
3. Refer to AC Electrical Test Conditions stated earlier in this document.
4. JTAG operations occur at one speed (10MHz). The base device may run at any speed specified in this datasheet.

## Identification Register Definitions

| Instruction Field                 | Value                 | Description                                          |
|-----------------------------------|-----------------------|------------------------------------------------------|
| Revision Number (31:28)           | 0x0                   | Reserved for version number                          |
| IDT Device ID (27:12)             | 0x0314 <sup>(1)</sup> | Defines IDT part number                              |
| IDT JEDEC ID (11:1)               | 0x33                  | Allows unique identification of device vendor as IDT |
| ID Register Indicator Bit (Bit 0) | 1                     | Indicates the presence of an ID register             |

5623 tbl 13

**NOTE:**

1. Device ID for IDT70V3399 is 0x0315.

## Scan Register Sizes

| Register Name        | Bit Size |
|----------------------|----------|
| Instruction (IR)     | 4        |
| Bypass (BYR)         | 1        |
| Identification (IDR) | 32       |
| Boundary Scan (BSR)  | Note (3) |

5623 tbl 14

## System Interface Parameters

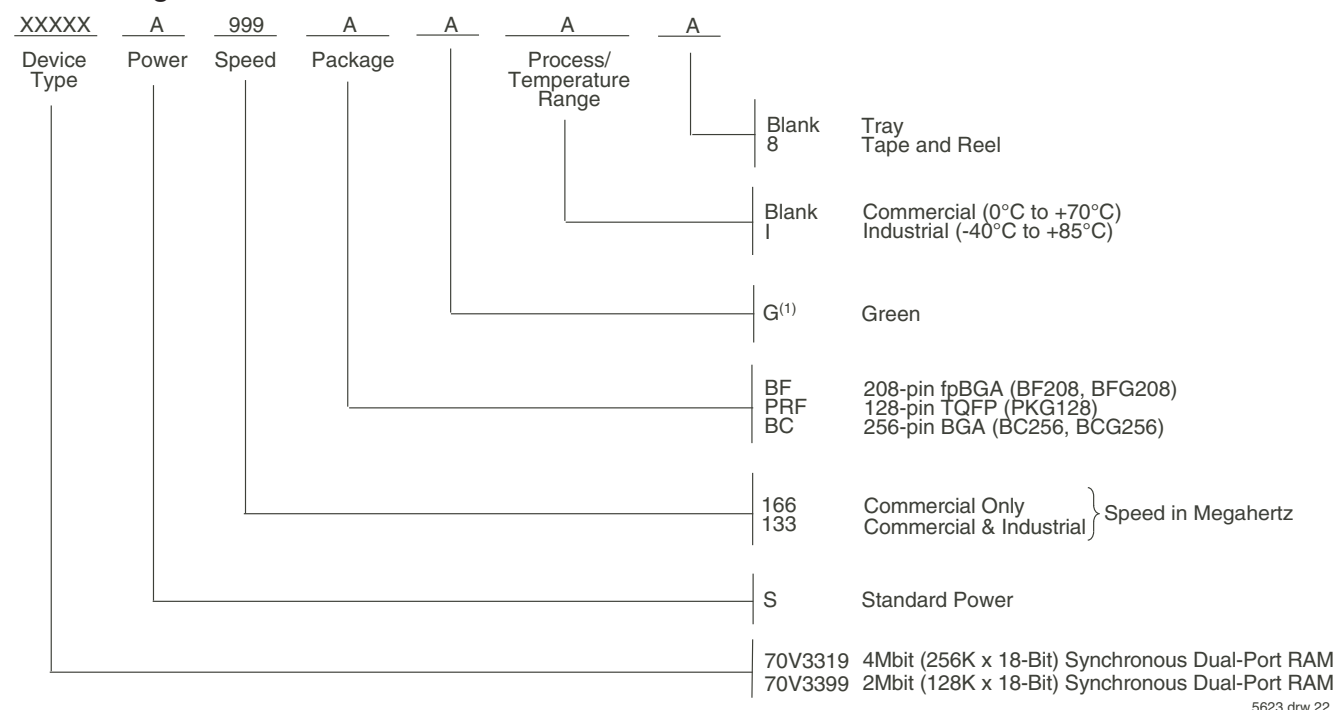
| Instruction    | Code            | Description                                                                                                                                                                                                                                                                      |
|----------------|-----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EXTEST         | 0000            | Forces contents of the boundary scan cells onto the device outputs <sup>(1)</sup> . Places the boundary scan register (BSR) between TDI and TDO.                                                                                                                                 |
| BYPASS         | 1111            | Places the bypass register (BYR) between TDI and TDO.                                                                                                                                                                                                                            |
| IDCODE         | 0010            | Loads the ID register (IDR) with the vendor ID code and places the register between TDI and TDO.                                                                                                                                                                                 |
| HIGHZ          | 0011            | Places the bypass register (BYR) between TDI and TDO. Forces all device output drivers to a High-Z state.                                                                                                                                                                        |
| SAMPLE/PRELOAD | 0001            | Places the boundary scan register (BSR) between TDI and TDO. SAMPLE allows data from device inputs <sup>(2)</sup> to be captured in the boundary scan cells and shifted serially through TDO. PRELOAD allows data to be input serially into the boundary scan cells via the TDI. |
| RESERVED       | All other codes | Several combinations are reserved. Do not use codes other than those identified above.                                                                                                                                                                                           |

5623 tbl 15

**NOTES:**

1. Device outputs = All device outputs except TDO.
2. Device inputs = All device inputs except TDI, TMS, and  $\overline{\text{TRST}}$ .
3. The Boundary Scan Descriptive Language (BSDL) file for this device is available on the IDT website ([www.idt.com](http://www.idt.com)), or by contacting your local IDT sales representative.

## Ordering Information



### NOTES:

- Contact your local sales office for industrial temp. range for other speeds, packages and powers.  
**LEAD FINISH (SnPb) parts are Obsolete excluding BGA & fpBGA. Product Discontinuation Notice - PDN# SP-17-02**  
 Note that information regarding recently obsoleted parts is included in this datasheet for customer convenience.

## Orderable Part Information

| Speed (MHz) | Orderable Part ID | Pkg. Code | Pkg. Type | Temp. Grade |
|-------------|-------------------|-----------|-----------|-------------|
| 133         | 70V3319S133BC     | BC256     | CABGA     | C           |
|             | 70V3319S133BC8    | BC256     | CABGA     | C           |
|             | 70V3319S133BCGI   | BCG256    | CABGA     | I           |
|             | 70V3319S133BCI    | BC256     | CABGA     | I           |
|             | 70V3319S133BCI8   | BC256     | CABGA     | I           |
|             | 70V3319S133BF     | BF208     | CABGA     | C           |
|             | 70V3319S133BF8    | BF208     | CABGA     | C           |
|             | 70V3319S133BFI    | BF208     | CABGA     | I           |
|             | 70V3319S133BFI8   | BF208     | CABGA     | I           |
|             | 70V3319S133PRFI   | PKG128    | TQFP      | I           |
|             | 70V3319S133PRFI8  | PKG128    | TQFP      | I           |
|             | 70V3319S133PRFI8  | PKG128    | TQFP      | I           |
| 166         | 70V3319S166BC     | BC256     | CABGA     | C           |
|             | 70V3319S166BC8    | BC256     | CABGA     | C           |
|             | 70V3319S166BCG    | BCG256    | CABGA     | C           |
|             | 70V3319S166BF     | BF208     | CABGA     | C           |
|             | 70V3319S166BF8    | BF208     | CABGA     | C           |
|             | 70V3319S166BFG    | BFG208    | CABGA     | C           |
|             | 70V3319S166BFG8   | BFG208    | CABGA     | C           |
|             | 70V3319S166PRFG   | PKG128    | TQFP      | C           |
|             | 70V3319S166PRFG8  | PKG128    | TQFP      | C           |
|             | 70V3319S166PRFG8  | PKG128    | TQFP      | C           |

| Speed (MHz) | Orderable Part ID | Pkg. Code | Pkg. Type | Temp. Grade |
|-------------|-------------------|-----------|-----------|-------------|
| 133         | 70V3399S133BC     | BC256     | CABGA     | C           |
|             | 70V3399S133BC8    | BC256     | CABGA     | C           |
|             | 70V3399S133BCI    | BC256     | CABGA     | I           |
|             | 70V3399S133BCI8   | BC256     | CABGA     | I           |
|             | 70V3399S133BF     | BF208     | CABGA     | C           |
|             | 70V3399S133BF8    | BF208     | CABGA     | C           |
|             | 70V3399S133BFI    | BF208     | CABGA     | I           |
|             | 70V3399S133BFI8   | BF208     | CABGA     | I           |
|             | 70V3399S133BFI8   | BF208     | CABGA     | I           |
|             | 70V3399S133BFI8   | BF208     | CABGA     | I           |
| 166         | 70V3399S166BC     | BC256     | CABGA     | C           |
|             | 70V3399S166BC8    | BC256     | CABGA     | C           |
|             | 70V3399S166BF     | BF208     | CABGA     | C           |
|             | 70V3399S166BF8    | BF208     | CABGA     | C           |
|             | 70V3399S166BFG    | BFG208    | CABGA     | C           |
|             | 70V3399S166BFG8   | BFG208    | CABGA     | C           |

## Datasheet Document History:

|           |                                                                                                                                                                              |
|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 06/02/00: | Initial Public Offering                                                                                                                                                      |
| 07/12/00: | Page 1 Added mux to functional block diagram                                                                                                                                 |
| 06/20/01: | Page 1 Added JTAG information for TQFP package                                                                                                                               |
|           | Page 4 Corrected TQFP package size                                                                                                                                           |
| 07/30/01: | Page 1 Added PL/FT option                                                                                                                                                    |
|           | Page 20 Changed maximum value for JTAG AC Electrical Characteristics for $t_{CD}$ from 20ns to 25ns                                                                          |
|           | Page 9 Added Industrial Temperature DC Parameters                                                                                                                            |
| 11/20/01: | Page 2, 3 & 4 Added date revision for pin configurations                                                                                                                     |
|           | Page 11 Changed $t_{OE}$ value in AC Electrical Characteristics, please refer to Errata #SMEN-01-05                                                                          |
|           | Page 1 & 22 Replaced $\text{TM}$ logo with $\text{®}$ logo                                                                                                                   |
|           | Page 10 Changed AC Test Conditions Input Rise/Fall Times                                                                                                                     |
| 08/06/02: | Consolidated multiple devices into one datasheet                                                                                                                             |
|           | Page 1 & 5 Added DCD capability for Pipelined Outputs                                                                                                                        |
|           | Page 7 Clarified $T_{BIAS}$ and added $T_{JN}$                                                                                                                               |
|           | Page 9 Changed DC Electrical Parameters                                                                                                                                      |
|           | Page 11 Removed Clock Rise & Fall Time from AC Electrical Characteristics Table                                                                                              |
|           | Removed Preliminary status                                                                                                                                                   |
| 05/19/03: | Page 11 Added Byte Enable Setup Time & Byte Enable Hold Time to AC Electrical Characteristics Table                                                                          |
|           | Page 22 Added IDT Clock Solution Table                                                                                                                                       |
| 02/08/06: | Page 1 Added green availability to features                                                                                                                                  |
|           | Page 6 Changed footnote 2 for Truth Table I from $\overline{ADS}, \overline{CNTEN}, \overline{REPEAT} = V_{IH}$ to $\overline{ADS}, \overline{CNTEN}, \overline{REPEAT} = X$ |
|           | Page 22 Added green indicator to ordering information                                                                                                                        |
| 07/25/08: | Page 9 Corrected a typo in the DC Chars table                                                                                                                                |
| 01/19/09: | Page 22 Removed "IDT" from orderable part number                                                                                                                             |
| 10/03/14: | Page 22 Added Tape & Reel to the Ordering Information                                                                                                                        |
| 06/20/18: | Product Discontinuation Notice - PDN# SP-17-02                                                                                                                               |
|           | Last time buy expires June 15, 2018                                                                                                                                          |
| 09/12/19: | Page 2, 3 & 4 Updated package codes                                                                                                                                          |
|           | Page 22 Added Orderable Part Information table and removed IDT Clock Solution table                                                                                          |
| 11/04/19: | Page 22 Corrected "ns" to "MHz" in the header of the Orderable Part Information tables                                                                                       |

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### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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